



Data Sheet

VT6105

*Rhine III 10/100 Mbps
PCI Fast Ethernet Controller
with ACPI Functions*

(Released under Creative Commons License)

Preliminary Revision 1.0

November 28, 2008

VIA TECHNOLOGIES, INC.

Copyright Notice:

Copyright © 2007-2008 VIA Technologies Incorporated.



Creative Commons License: Free to copy and distribute. Not allow to modify. Retain the identity of authorship.

This document is provided under the terms of the Creative Commons Public License. The work is protected by copyright and/or other applicable law. Any use of the work other than as authorized under this license or copyright law is prohibited.

Trademark Notices:

VT6105 may only be used to identify a product of VIA Technologies, Incorporated.

Windows 98™, Windows NT™, Windows 2000™ and Plug and Play™ are registered trademarks of Microsoft Corporation.

PCI™ is a registered trademark of the PCI Special Interest Group.

All trademarks are the properties of their respective owners.

Disclaimer Notice:

No license is granted, implied or otherwise, under any patent or patent rights of VIA Technologies. VIA Technologies makes no warranties, implied or otherwise, in regard to this document and to the products described in this document. The information provided by this document is believed to be accurate and reliable as of the publication date of this document. However, VIA Technologies assume no responsibility for any errors in this document. Furthermore, VIA Technologies assume no responsibility for the use or misuse of the information in this document and for any patent infringements that may arise from the use of this document. The information and product specifications within this document are subject to change at any time, without notice and without obligation to notify any person of such change.

Offices:

VIA Technologies Incorporated

Taiwan Office:

1st Floor, No. 531

Chung-Cheng Road, Hsin-Tien

Taipei, Taiwan ROC

Tel: 886-2-2218-5452

FAX: 886-2-2218-5453

Home page: <http://www.via.com.tw>

VIA Technologies Incorporated

USA Office:

940 Mission Court

Fremont, CA 94539

USA

Tel: 510-683-3300

FAX: 510-683-3301 or 510-687-4654

Home Page: <http://www.viatech.com>

TABLE OF CONTENTS

TABLE OF CONTENTS	I
LIST OF FIGURES	III
LIST OF TABLES	IV
PRODUCT FEATURES	1
OVERVIEW	3
PINOUT	4
PIN DESCRIPTIONS	6
REGISTERS	10
REGISTER OVERVIEW	10
REGISTER SUMMARY	10
PCI Configuration Registers	10
Internal Registers (00h-FFh)	10
PHY Registers (00h-1Fh)	11
REGISTER DESCRIPTIONS	12
PCI Configuration Registers	12
Internal Registers	13
PHY Registers	18
FUNCTIONAL DESCRIPTIONS	22
HOST BUS INTERFACE CONTROL LOGIC	22
PCI Master Function	22
PCI Slave Function	22
BUFFER MANAGEMENT	22
Receive Descriptor Packet Layout (RD)	23
Transmit Descriptor Packet Layout (TD)	24
FIFO AND CONTROL LOGIC	25
NETWORK INTERFACE	25
100BaseT Transceiver Auto MDI/MDIX Configuration Function	25
LED Status and PHY Force Fiber Mode Strapping	25
EEPROM INTERFACE	26
EEPROM Direct Programming	26
EEPROM Embedded Programming	26
EEPROM Contents	27
INTERRUPT CONTROL	28
FLOW CONTROL	28
POWER MANAGEMENT	29
Wake-up Events	29
ELECTRICAL SPECIFICATIONS	30
ABSOLUTE MAXIMUM RATINGS	30
DC SPECIFICATIONS	30

POWER CONSUMPTION.....	31
TIMING SPECIFICATIONS.....	32
PCI Bus Master.....	32
PCI Bus Slave.....	34
BootROM	35
Embedded Flash Cycle Timing	36
LED Identification.....	38
TP Interface	39
MECHANICAL SPECIFICATIONS	41

LIST OF FIGURES

FIGURE 1. INTERNAL BLOCK DIAGRAM.....	3
FIGURE 2. PIN DIAGRAM.....	4
FIGURE 3. BUFFER STRUCTURE	22
FIGURE 4. RECEIVE DESCRIPTOR PACKET LAYOUT	23
FIGURE 5. TRANSMIT DESCRIPTOR PACKET LAYOUT.....	24
FIGURE 6. INTERRUPT CONTROL	28
FIGURE 7. DESCRIPTOR FETCH.....	32
FIGURE 8. WRITE BACK STATUS TO DESCRIPTOR	32
FIGURE 9. MEMORY READ (TX FIFO DMA)	33
FIGURE 10. MEMORY WRITE (RX FIFO DMA).....	33
FIGURE 11. I/O READ/WRITE	34
FIGURE 12. CONFIGURATION READ/WRITE	34
FIGURE 13. BOOT ROM ACCESS (WITH DELAY TRANSACTION).....	35
FIGURE 14. BOOT ROM ACCESS TIMING (WITHOUT DELAY TRANSACTION).....	35
FIGURE 15. FLASH WRITE TIMING (WE# CONTROLLED ONLY)	36
FIGURE 16. FLASH READ TIMING	37
FIGURE 17. LED ON/OFF (0 < TPD < 300).....	38
FIGURE 18. 10BASE-T NORMAL LINK PULSE TIMING (0 < TPD < 300).....	39
FIGURE 19. AUTO NEGOTIATION FAST LINK PULSE TIMING (0 < TPD < 300).....	39
FIGURE 20. RUNNING STATE SOFTWARE DRIVEN INTERNAL PHY RESET TIMING	40
FIGURE 21. PQFP-128 PACKAGE (14 × 20 MM).....	41
FIGURE 22. LEAD-FREE PQFP-128 PACKAGE (14 × 20 MM).....	42
FIGURE 23. LEAD-FREE PQFP-128 PACKAGE (14 × 20 MM).....	43

LIST OF TABLES

TABLE 1. PIN LIST	5
TABLE 2. SIGNAL TYPE DEFINITIONS.....	5
TABLE 3. PIN DESCRIPTIONS	6
TABLE 4. REGISTER SUMMARY TABLES	10
TABLE 5. RECEIVE DESCRIPTOR 0 (RDES0)	23
TABLE 6. RECEIVE DESCRIPTOR 1 (RDES1)	23
TABLE 7. RECEIVE DESCRIPTOR 2 (RDES2)	23
TABLE 8. RECEIVE DESCRIPTOR 3 (RDES3)	23
TABLE 9. TRANSMIT DESCRIPTOR 0 (TDES0)	24
TABLE 10. TRANSMIT DESCRIPTOR 1 (TDES1)	24
TABLE 11. TRANSMIT DESCRIPTOR 2 (TDES2)	24
TABLE 12. TRANSMIT DESCRIPTOR 3 (TDES3)	24
TABLE 13. LED STATUS	25
TABLE 14. CHIP CONFIGURATION EEPROM CONTENTS.....	27
TABLE 15. POWER STATES.....	29
TABLE 16. ABSOLUTE MAXIMUM RATINGS.....	30
TABLE 17. DC SPECIFICATIONS	30
TABLE 18. VT6105 POWER CONSUMPTION	31

VT6105

Rhine III

10/100 Mbps PCI Fast Ethernet Controller with ACPI Functions

PRODUCT FEATURES

- **Single Chip Fast Ethernet Network Interface Controllers (NICs) for the PCI Bus**
 - PCI 2.2 specification compliant
 - Provide a direct connection to the PCI bus
 - Support 10/100 Mbps ethernet communications with Boot ROM interface
- **High Performance PCI Mastering Structure**
 - VIA-defined 256 byte I/O-based or memory-mapped-I/O-based command and status registers
 - Software oriented chain structure description to minimize hardware complexity
 - On chip bus master DMA with programmable burst length for high PCI bus utilization
 - Transmit data buffer byte-alignment for low CPU utilization
 - Dynamic transmit packet auto-queuing for back-to-back transmission
 - Programmable activity polling intervals for description DMA
 - Programmable DMA arbitration priority to minimize overflow conditions
 - PCI enhance command capable
- **Provides Standard 10Base-T/100Base-Tx/PHY Layer and Transceiver**
 - Supports 10Base-T/100Base-TX with CAT5 UTP, STP and fiber cables
 - 10/100 Mbps full duplex, half duplex operation
 - Auto MDI/MDIX functions N-Way enable or PHY force-media mode
 - Auto Power-saving at cable not link
 - Four LED outputs, including Link, Duplex, Speed, and Collision status
- **Separate 2K Byte Receive and Transmit FIFOs**
 - Both support bursts of up to full Ethernet length
- **Flexible Dynamic-Load EEPROM Algorithm**
 - Load after power-up
 - Dynamic auto reload
 - Embedded programming for configuration modification
 - Dynamic direct programming for manufacturing
- **External Boot ROM**
 - Up to 64K Bytes
 - No external address latch required
 - Supports EPROM read and Flash ROM read/write

- **ACPI**
 - Supports PC99, PC2001 and Net PC requirements
 - Supports PCI Bus Power Management Interface Specification Version 1.0/1.1
 - Supports Advanced Configuration and Power Interface (ACPI) Specification 1.0
 - Supports Network Device Class Power Management Specification Version 1.0a
 - Wake-up even support link change/magic packet/unicast physical address/MS define pattern match
- **Flow Control**
 - Supports IEEE 802.3X for full duplex
 - Multiple pause frame Xon/Xoff
- **Dual Power Design: 3.3V I/O Power and 2.5V Core Power**
- **128-Pin PQFP Package (14x20mm Rectangular Package Body)**

OVERVIEW

The VIA VT6105 “Rhine III” Ethernet controller is a cutting edge, feature-rich, and cost-competitive single ASIC chip solution for PC NIC adapters. The VT6105 eases server processor utilization by optimizing throughput between the NIC and PCI bus allowing data transfers of up to at 200Mbps in full duplex mode, without using the system CPU. The VT6105 features extensive troubleshooting features including auto MDI/MDIX configuration and remote BootROM ability. The VT6105 also contains advanced power management features for low power consumption including Wake on LAN (WOL) and is implemented using a low power 0.22 micron design.

The VIA VT6105 is ideal for integration into network controllers, network workstations, NICs, or LAN-on-motherboard solutions, providing a manageable, integrated controller to bring high speed Ethernet connectivity to the electronics of tomorrow.

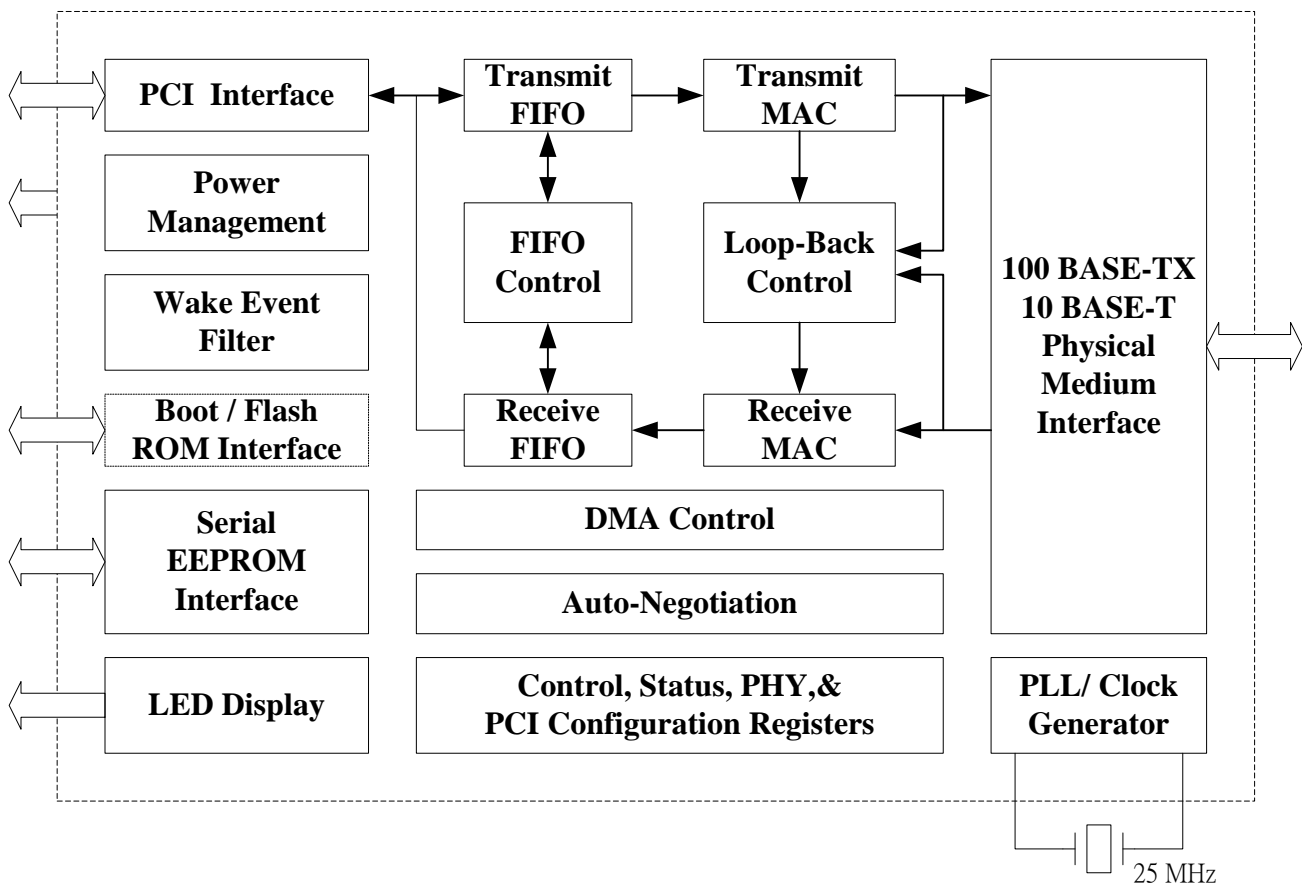


Figure 1. Internal Block Diagram

PINOUT

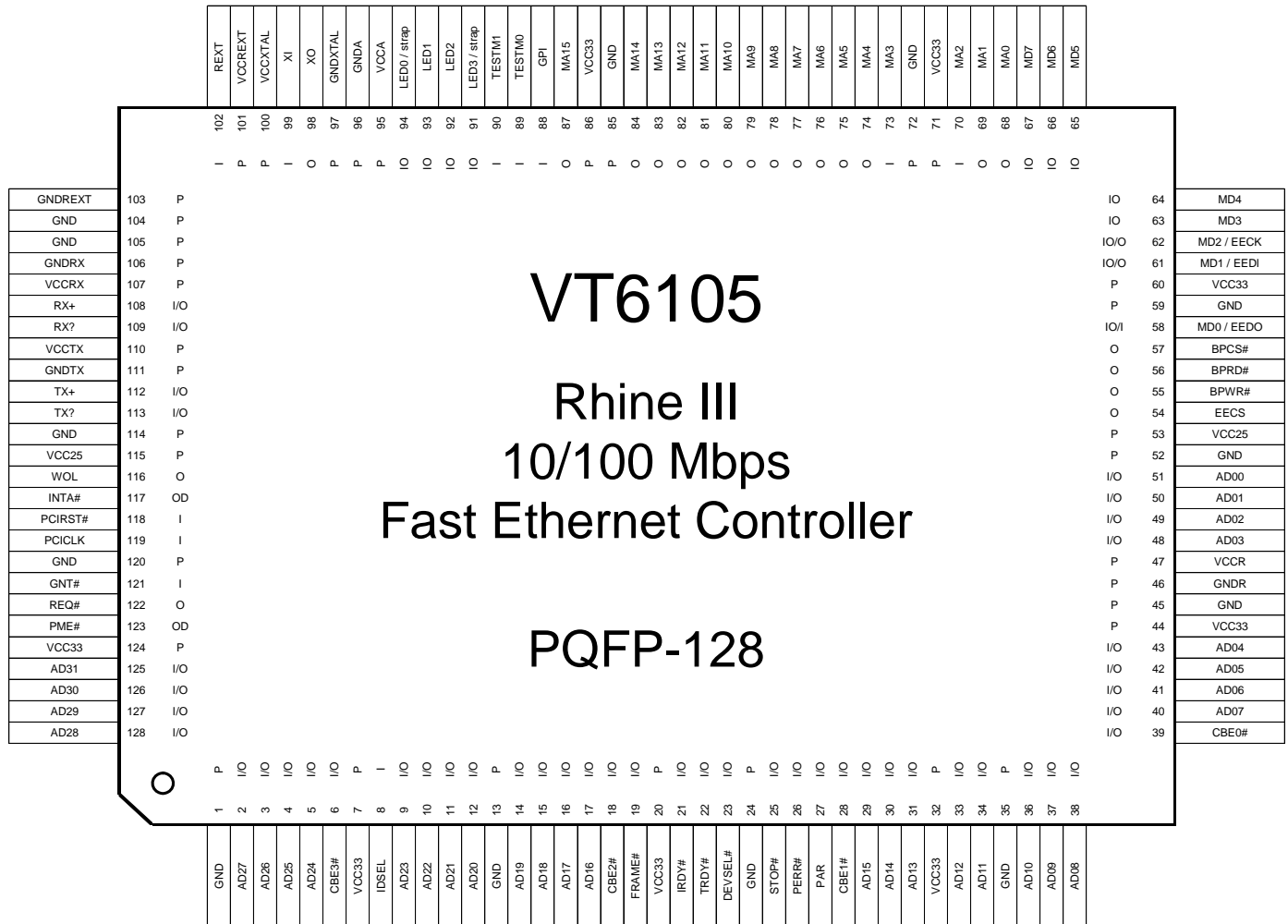


Figure 2. Pin Diagram

Table 1. Pin List

Name	No.	Type	Name	No.	Type	Name	No.	Type	Name	No.	Type
AD00	51	I/O	BPCS#	57	O	INTA#	117	OD	PCIRST#	118	I
AD01	50	I/O	BPRD#	56	O	IRDY#	21	I/O	PERR#	26	I/O
AD02	49	I/O	BPWR#	55	O	LED0 / strap	94	IO	PME#	123	OD
AD03	48	I/O	CBE0#	39	I/O	LED1	93	IO	REQ#	122	O
AD04	43	I/O	CBE1#	28	I/O	LED2	92	IO	REXT	102	I
AD05	42	I/O	CBE2#	18	I/O	LED3 / strap	91	IO	RX+	108	I/O
AD06	41	I/O	CBE3#	6	I/O	MA0	68	O	RX?	109	I/O
AD07	40	I/O	DEVSEL#	23	I/O	MA1	69	O	STOP#	25	I/O
AD08	38	I/O	EECS	54	O	MA10	80	O	TESTM0	89	I
AD09	37	I/O	FRAME#	19	I/O	MA11	81	O	TESTM1	90	I
AD10	36	I/O	GND	1	P	MA12	82	O	TRDY#	22	I/O
AD11	34	I/O	GND	13	P	MA13	83	O	TX+	112	I/O
AD12	33	I/O	GND	24	P	MA14	84	O	TX?	113	I/O
AD13	31	I/O	GND	35	P	MA15	87	O	VCC25	53	P
AD14	30	I/O	GND	45	P	MA2	70	I	VCC25	115	P
AD15	29	I/O	GND	52	P	MA3	73	I	VCC33	7	P
AD16	17	I/O	GND	59	P	MA4	74	O	VCC33	20	P
AD17	16	I/O	GND	72	P	MA5	75	O	VCC33	32	P
AD18	15	I/O	GND	85	P	MA6	76	O	VCC33	44	P
AD19	14	I/O	GND	104	P	MA7	77	O	VCC33	60	P
AD20	12	I/O	GND	105	P	MA8	78	O	VCC33	71	P
AD21	11	I/O	GND	114	P	MA9	79	O	VCC33	86	P
AD22	10	I/O	GND	120	P	MD0 / EEDO	58	IO/I	VCC33	124	P
AD23	9	I/O	GND	96	P	MD1 / EEDI	61	IO/O	VCCA	95	P
AD24	5	I/O	GND	46	P	MD2 / EECK	62	IO/O	VCCR	47	P
AD25	4	I/O	GND	103	P	MD3	63	IO	VCCREXT	101	P
AD26	3	I/O	GND	106	P	MD4	64	IO	VCCRX	107	P
AD27	2	I/O	GND	111	P	MD5	65	IO	VCCTX	110	P
AD28	128	I/O	GND	97	P	MD6	66	IO	VCCXTAL	100	P
AD29	127	I/O	GND	121	I	MD7	67	IO	WOL	116	O
AD30	126	I/O	GND	88	I	PAR	27	I/O	XI	99	I
AD31	125	I/O	GND	8	I	PCICLK	119	I	XO	98	O

Table 2. Signal Type Definitions

Type	Description
I	Input. Standard input-only signal.
O	Output. Standard active output driver.
I/O	Input/output. An input/output signal.
T/S	Tri-state. Inactive bi-directional input/output pin.
OD	Open drain. Allows multiple devices to share as a wire-OR.
A _{DIFF}	Analog differential. Signal pair for the twisted-pair interface.
A _{BIAS}	Analog bias or reference signal. Must be tied to external resistor and/or capacitor bias network, as shown in the system schematic.

Pin Descriptions
Table 3. Pin Descriptions

PCI Bus Interface			
<u>Signal Name</u>	<u>Pin #</u>	<u>I/O</u>	<u>Signal Description</u>
AD[31:0]	(see pin list)	I/O	Address and Data. Address and data are multiplexed on the same PCI pins. A bus transaction consists of an address phase followed by one or more data phases. The address phase is the clock cycle in which FRAME# is asserted. In the data phase of the clock cycle IRDY# and TRDY# are both asserted. Write data is stable and valid when IRDY# is asserted and read data is stable and valid when TRDY# is asserted.
CBE#[3:0]	6, 18, 28, 39	I/O	Bus Command/Byte Enable. These commands are multiplexed on the same PCI pins. During the address phase of a transaction, CBE#[3:0] defines the Bus Command. During the data phase, CBE#[3:0] uses the Byte Enable command. The Byte Enables define which physical byte lanes on the bus carry the data. CBE#[0] applies to byte 0 and CBE#[3:0] applies to byte 3.
PAR	27	I/O	Parity. Even parity across AD[31-0] and CBE#[3-0]. PAR is stable and valid one clock after the address phase. For data phases PAR is stable and valid one clock after either IRDY# is asserted on a write transaction or TRDY# is asserted on a read transaction.
IDSEL	8	I	Initialization Device Select. Used as a chip select during PCI configuration read and write-cycles.
FRAME#	19	I/O	Frame. Cycle Frame is driven by the current bus master to indicate the address stage that marks the beginning and duration of a bus transaction. During the address stage the FRAME# is asserted low to indicate that a bus transaction is beginning. While the FRAME# is asserted, data transfers continue. When the FRAME# is negated, the transaction is in the final data phase.
DEVSEL#	23	I/O	Device Select. When actively driven, indicates the driving device has decoded its address as the target of the current access. As an input, DEVSEL# indicates whether any device on the bus has been selected.
IRDY#	21	I/O	Initiator Ready. Indicates the initiating agent's ability to complete the current data phase of the transaction. IRDY# is used in conjunction with TRDY#. A data phase is completed on any clock when both IRDY# and TRDY# are asserted. During a write cycle, IRDY# indicates that transferring data is present on AD[31:0]. During a read cycle, it indicates the master is prepared to accept data. Wait cycles are inserted until both IRDY# and TRDY# are asserted simultaneously.
TRDY#	22	I/O	Target Ready. Indicates the target agent's ability to complete the current data phase of the transaction. TRDY# is used in conjunction with IRDY#. A data phase is completed on any clock when both IRDY# and TRDY# are asserted. During a read, TRDY# indicates that valid data is present on AD31-0. During a write, it indicates the target is prepared to accept data. Wait cycles are inserted until both IRDY# and TRDY# are asserted simultaneously.
STOP#	25	I/O	Stop. The VT6105 drives STOP# to discontinue further action.
PERR#	26	I/O	Parity Error. Asserts when a data parity error is detected.
REQ#	122	O	Bus Request. Asserted by the VT6105 indicate to the PCI bus arbiter that it wants to use the bus for bus master operations.
GNT#	121	I	Bus Grant. Asserts to indicate to the VT6105 that access to the bus is granted.
INTA#	117	OD	Interrupt. An asynchronous signal used to request an interrupt
PCICLK	119	I	PCI Clock. Provides timing for all transactions on the PCI bus and is an input pin to every PCI device.
PCIRST#	118	I	PCI Reset. When PCIRST# is asserted low, the VT6105 chip performs an internal system hardware reset. PCIRST# may be asynchronous to PCICLK when asserted or negated, but it is recommended that the negation be synchronous to guarantee a clean and bounce-free signal edge.

Boot ROM/EEPROM Interface			
<u>Signal Name</u>	<u>Pin #</u>	<u>I/O</u>	<u>Signal Description</u>
MA[15:0]	(see pin list)	O	Boot ROM Address. MA2 and MA3 are also used as power-up straps: MA2. PHY: MDI/MDIX function disable when pull up, default is enable. MA3. Must be pulled up with 10k external resistor for normal operation.
BPWR#	55	O	Boot ROM Write Enable. Used to write to the Boot ROM if it is writable (flash).
BPRD#	56	O	Boot ROM Read Enable. Used to read Boot ROM data on the memory data bus.
BPCS#	57	O	Boot ROM Chip Select. Used to select the Boot ROM for a read or write.
MD7	67	IO	Boot ROM Data Bus/Serial EEPROM Control. EECK = Serial EEPROM Clock. EEDI = Serial EEPROM Data In. EEDO = Serial EEPROM Data Out.
MD6	66	IO	
MD5	65	IO	
MD4	64	IO	
MD3	63	IO	
MD2/EECK	62	IO/O	
MD1/EEDI	61	IO/O	
MD0/EEDO	58	IO/I	
EECS	54	O	Serial EEPROM Chip Select. Chip select signal for an external serial EEPROM when an EEPROM is used to provide the configuration data and Ethernet Address.

Boot ROM/EEPROM Interface			
<u>Signal Name</u>	<u>Pin #</u>	<u>I/O</u>	<u>Signal Description</u>
MA[15:0]	(see pin list)	O	Boot ROM Address. MA2 and MA3 are also used as power-up straps: MA2. PHY: MDI/MDIX function disable when pull up, default is enable. MA3. Must be pulled up with 10k external resistor for normal operation.
BPWR#	55	O	Boot ROM Write Enable. Used to write to the Boot ROM if it is writable (flash).
BPRD#	56	O	Boot ROM Read Enable. Used to read Boot ROM data on the memory data bus.
BPCS#	57	O	Boot ROM Chip Select. Used to select the Boot ROM for a read or write.
MD7	67	IO	Boot ROM Data Bus/Serial EEPROM Control. EECK = Serial EEPROM Clock. EEDI = Serial EEPROM Data In. EEDO = Serial EEPROM Data Out.
MD6	66	IO	
MD5	65	IO	
MD4	64	IO	
MD3	63	IO	
MD2/EECK	62	IO/O	
MD1/EEDI	61	IO/I	
MD0/EEDO	58	IO/O	
EECS	54	O	Serial EEPROM Chip Select. Chip select signal for an external serial EEPROM when an EEPROM is used to provide the configuration data and Ethernet Address.

LED Interface

<u>Signal Name</u>	<u>Pin #</u>	<u>I/O</u>	<u>Signal Description</u>
LED3/strap	91	O/I	LED Identification. LED displays for network traffic status identification. The LED select bits in PHY register Rx10 can be used to set the LED definitions. The default LED definitions are: LED0: Link/Act LED1: Speed LED2: Duplex LED3: Collision The LED0 and LED3 pins are also used as power-up straps: Need external resistor to pull up or pull down. LED0 strap = Test Mode (0 = Internal PHY test mode, 1 = normal operation) LED3 strap = N-Way Enable (0 = disable, 1 = enable)
LED2	92	O	
LED1	93	O	
LED0/strap	94	O/I	

Power Management Interface

<u>Signal Name</u>	<u>Pin #</u>	<u>I/O</u>	<u>Signal Description</u>
WOL	116	O	Wake on LAN Event. Active high, programmable pulse or button WOL event
PME#	123	OD	Power Management Event. Power management interrupt output

Physical Cable Connection

<u>Signal Name</u>	<u>Pin #</u>	<u>I/O</u>	<u>Signal Description</u>
TX+, TX-	112,113	IO	Differential Transmit Pair. 10/100 Base-T/TX transmit data
RX+, RX-	108,109	IO	Differential Receive Pair. 10/100 Base-T/TX receive data

Clocks, Control and Test

<u>Signal Name</u>	<u>Pin #</u>	<u>I/O</u>	<u>Signal Description</u>
XI	99	I	Crystal In. Connect to 25 MHz crystal with (22pF 5%) pF capacitor connection to GNDOSC. Can alternately be driven by an external clock source (3.3V voltage swing) with XO unconnected.
XO	98	O	Crystal Feedback. Connect to other side of 25 MHz crystal and to 22pF 5% GNDOSC capacitor.
REXT	102	I	External Resistor. Connect 6.04 K Ω 1% resistor to GND.
GPI	88	I	Connect to PCI power to detect PCI power status and Wake On LAN usage. Must be pulled up to PCI5V with a 10K ohm resistor.
TESTM0	89	I Pull Low	Test and Operation Mode Select 0. (For internal use)
TESTM1	90	I Pull Low	Test and Operation Mode Select 1. (For internal use)

Digital Power and Ground			
Signal Name	Pin #	I/O	Signal Description
VCC33	7, 20, 32, 44, 60, 71, 86, 124	P	I/O Power. +3.3V \pm 5%
VCC25	115, 53	P	Core Power. +2.5V \pm 5%
GND	1, 13, 24, 35, 45, 52, 59, 72, 85, 114, 120	P	Digital Ground. Connect directly to main PCB ground plane.
VCCR	47	P	Internal Core Power. +2.5V \pm 5%
GNDR	46	P	Internal Ground. Connect directly to main PCB ground plane.

Analog Power and Ground			
Signal Name	Pin #	I/O	Signal Description
VCCA	95	P	Analog Power. 2.5V \pm 5% power for internal analog circuitry.
GND A	96	P	Analog Ground. Connect to analog ground.
VCCTX	110	P	PHY Transmitter Power. 2.5V \pm 5% power for internal PHY transmitter circuitry.
GNDTX	111	P	PHY Transmitter Ground. Connect to analog ground.
VCCR X	107	P	PHY Receiver Power. 2.5V \pm 5% power for internal PHY receiver circuitry.
GNDRX	106	P	PHY Receiver Ground. Connect to analog ground.
VCCREXT	101	P	External Resistor Circuit Power. 2.5V \pm 5% power for internal analog circuitry associated with the external resistor REXT.
GNDREXT	103	P	External Resistor Circuit Ground. Connect to analog ground.
VCCXTAL	100	P	Crystal Oscillator Power. 2.5V \pm 5% power for internal crystal oscillator circuit.
GNDXTAL	97	P	Crystal Oscillator Ground. Connect to analog ground.

REGISTERS

Register Overview

The tables in this section describe the register settings for the VT6105. The registers in this section are listed according to their offset values. The tables show the Access Type (Read/Only, Read/Write, and Read/Write/Clear) and power-on default values (Default). All offset values are shown in hexadecimal unless otherwise indicated. Default values for each register are also indicated in hexadecimal notation.

Note: Registers indicated as RW may have some read/only bits that always read back a fixed value (usually 0 if unused); registers assigned as RWC or WC may have some read-only or read-write bits (see individual register descriptions for details)

Register Summary

Table 4. Register Summary Tables

PCI Configuration Registers

Offset	Configuration Space Header	Default	Acc
1-0	Vendor ID	1106	RO
3-2	Device ID	3106	RO
5-4	Command	0097	RW
7-6	Status	0210	RO
8	Revision ID	nn	RO
9-B	Class Code	02 00 00	RO
C	Cache Line Size	08	RW
D	Latency Timer	40	RW
E	Header Type	00	RO
F	BIST	00	RO
14-10	IO Base Address	0000D801	RO
18-14	MEH Base Address	F6 80 00 00	RO
2B-18	-reserved-	—	—
2D-2C	Sub Vender ID	1106	RO
2F-2E	Sub System ID	0105	RO
33-30	Expansion ROM Base Address	—	RW
34	Capability Pointer	40	RO
3B-35	-reserved-	00	RO
3C	Int Line	—	RO
3D	Int Pin	—	RO
3E	Min_GNT	3	RO
3F	Max_LAT	8	RO
40	Cap ID	1	RO
40-35	-reserved-	00	—
41	Next Item Pointer	00	RO
43-42	Power Management Event	00	RO
4F-44	Power Management Ctrl/Status		RWC
FF-50	-reserved-	00	—

Internal Registers (00h-FFh)

Offset	Control/Status/Interrupts	Default	Acc
5-0	MAC Address 0-5 (PAR 0-5)	6 x 00	RW
6	Receive Control (RCR)	0	RW
7	Transmit Control (TCR)	0	RW
8	Command (CR0)	04	RW
9	Command (CR1)	08	RW
A-B	-reserved-	00	—
C	Interrupt Service 0 (ISR0)	—	RWC
D	Interrupt Service 1 (ISR1)	00	RWC
E	Interrupt Enable Mask 0 (IMR0)	0	RW
F	Interrupt Enable Mask 1 (IMR1)	0	RW
17-10	Multicast Hashing Table 0-7 (MAR0-MAR7)	8x FF	RW
1B-18	Rx Queue Descriptor Base Address	0	RW
1F-1C	Tx Queue Descriptor Base Address	0	RW
3B-20	-reserved-	00	—
6B-3C	Test (Do Not Program)	00	—

Offset	Media Independent Interface	Default	Acc
6C	MII Configuration (MII_CFG)	01	RW
6D	MII Status (MII_SR)	13	RW
6E	Bus Control 0 (BCR0)	09	RW
6F	Bus Control 1 (BCR1)	0E	RW
70	MII Control (MII_CR)	0	RW
71	MII Port Address (MII_PA)	81	RW
73-72	MII R/W Data Port (MII_RWDR)	7849	RW

Internal Registers (continued)

Offset	ROM/Chip Config/Misc	Default	Acc
74	EEPROM Ctrl/Status (EECSR)	80	RW
78	Chip Configuration A (CFG_A)	12	RW
79	Chip Configuration B (CFG_B)	00	RW
7A	Chip Configuration C (CFG_C)	40	RW
7B	Chip Configuration D (CFG_D)	82	RW
7F-7C	-reserved-	00	—
81-80	Misc Command (MCR0-MCR1)	0000	RW
82	PM Capability Control (PMCCR)	1F	RW
83	Sticky Bit H/W Shadow (SBHS)	00	RW
84	Misc Interrupt Status (MISR)	00	RWC
86	Misc Int Ena Mask (MIMR)	0	RW
8B-88	-reserved-	—	—

Offset	Flash/ROM Control	Default	Acc
8D-8C	Flash Programming Address	0000	RW
8F	Flash ROM Data	00	RW
8E	Reserved for Test (Do Not Program)	00	RW
90	Flash Command	80	RW
91	Flash Read Data	00	RW
97-92	-reserved-	00	—

Offset	Flow Control	Default	Acc
98	Flow Control 0 (FCR0)	00	RW
99	Flow Control 1 (FCR1)	00	RW
9B-9A	Pause Timer	0000	RW
9F-9C	Soft Timer		RW

Offset	Wake-On LAN (WOL)	Default	Acc
A4/A0	WOL Command Set/Clear (WOLCR SET/WOLCR CLR)	00/00	RWC
A5/A1	Power Configuration Set/Clear (PWCFG SET/PWCFG CLR)	10/10	RWC
A6/A2	Test (Do Not Program)	04/04	—
A7/A3	Wake-Up LAN Control (WOLCG SET/WOLCG CLR)	0/0	RWC
AC/A8	WOL Status 0 (WOL SR0)	00/00	RWC
AD/A9	WOL Status 1 (WOL SR1)	00/00	RWC
AE/AA	-reserved-	00/00	—
AF/AB	-reserved-	00/00	—

Offset	CRC/Byte Mask	Default	Acc
BF-B0	CRC Pattern 0-3 (CRC0-CRC3)	16x FF	RW
CF-C0	Byte Mask 0	16x 00	RW
DF-D0	Byte Mask 1	16x 00	RW
EF-E0	Byte Mask 2	16x 00	RW
FF-F0	Byte Mask 3	16x 00	RW

PHY Registers (00h-1Fh)

Offset	Internal Registers	Default	Acc
0	PHY Control	3100	RW
1	PHY Status	7849	RO
2	PHY Identifier 0	0101	RO
3	PHY Identifier 1	8F43	RO
4	Auto-Negotiation Base Page Advertisement	05E1	RW
5	Auto-Negotiation Link Partner Base Page Ability	0000	RO
6	Auto-Negotiation Expansion	0004	RO
7	Auto-Negotiation Next Page Transmit	0000	RW
8	Auto-Negotiation Link Partner Received Next Page	0000	RO
F-9	-reserved-	—	—
10	PHY Configuration 1	0800	RW
11	PHY Configuration 2	F7FF	RW
12	PHY Configuration 3	0800	RW
13	PHY Interrupt Mask	FFFC	RW
14	PHY Status	0000	RO
18-15	Reserved (Do Not Program)	—	—
19	Power Control	0001	RW
1F-1A	Reserved (Do Not Program)	—	—

Register Descriptions

PCI Configuration Registers

Offset 1-0 - Vendor ID (1106h)RO

15-0 ID Code (reads 1106h to identify VIA Technologies)

Offset 3-2 - Device ID (3106h).....RO

15-0 ID Code (reads 3106h to identify the VT6105)

Offset 5-4 - Command (0006h)RW

- 15-10 Reserved always reads 0
- 9 Fast Back-to-Back Enable..... always reads 0
- 8 SERR# Enable..... always reads 0
- 7 Wait Cycle Control..... always reads 0
- 6 Parity Error Response..... always reads 0
- 5 VGA Palette Snoop..... always reads 0
- 4 Memory Write & Invalidate Enable always reads 0
- 3 Special Cycles Enable..... always reads 0
- 2 PCI Bus Master Enable..... always reads 0
- 1 Memory Space Enable..... always reads 0
- 0 I/O Space Enable always reads 0

Offset 7-6 - Status (0290h).....RWC

- 15 Detected Parity Error..... always reads 0
- 14 Signaled System Error always reads 0
- 13 Received Master Abort always reads 0
- 12 Received Target Abort always reads 0
- 11 Signaled Target Abort..... always reads 0
- 10-9 DEVSEL# Timing
 - 00 Fast
 - 01 Mediumalways reads 01
 - 10 Slow
 - 11 Reserved
- 8 Data Parity Error Detected..... always reads 0
- 7 Fast Back-to-Back Capablealways reads 1
- 6 User Definable Features..... always reads 0
- 5 66 MHz Capable always reads 0
- 4 Power Management Capabilities.....always reads 1
- 3-0 Reserved always reads 0

Offset 8 - Revision ID (nnh)RO

7-0 Revision ID always reads current chip revision #

Offset B-9 - Class Code.....RO

Identifies the generic function of the device and specific register-level programming interfaces.

31-8 Class Code default = 00 00 00h

Offset C - Cache Line Size.....RW

Implemented by master devices that are able to generate the memory write command as well as the memory invalidate command.

7-0 Cache Line Size..... default = 00h

Offset D - Latency Timer RW

Implemented as write able by a master device that can burst more than two data phases.

7-0 Latency Timer default = 00h

Offset E - Header Type RO

Refer to the PCI version 2.1 Specification.

7-0 Header Type default = 00h

Offset F - Built In Self Test (BIST) (00h) RO

7-0 BIST default = 00h

Offset 34 - Capability Pointer..... RO

Provides an offset into the function's PCI configuration space for the location of the first item in the Capabilities linked list

7-0 Capability Pointer default = 00h

Offset 41 - Next Item Pointer RO

Provides an offset into the function's PCI configuration space pointing to the location of the next item in the function's capability list

7-0 Next Item Pointer default = 00h

Offset 43-42 - Power Management Event..... RO

15-11 PME_Supp..... RO

This 5 bit field indicates the power state in which the function may assert PME#.

- 1xxxx PME# can be asserted from D3cold
- x1xxx PME# can be asserted from D3hot
- xx1xx PME# can be asserted from D2
- xxx1x PME# can be asserted from D1
- xxxx1 PME# can be asserted from D0

10-0 Reservedalways reads 0

Offset 4F-44 - Power Management Control StatusRWC

Refer to Power Management spec 1.0.

Internal Registers

Offset 5-0 - Ethernet AddressRW

63-0 Ethernet AddressPAR0-PAR5
Loaded from EEPROM at power up

Offset 6 - Receive Configure Request.....RW

- 7-5 Reserved** always reads 0
- 4 Physical Address Packets Accepted**
 - 0 Physical address must match node address in PAR0-5.
 - 1 All packets with physical destination address are accepted
- 3 Broadcast Packets Accepted**
 - 0 Packets with broadcast address are rejected
 - 1 Packets with broadcast address are accepted
- 2 Multicast Packets Accepted**
 - 0 Packet with multicast are rejected
 - 1 Packets with multicast address hit hashing table defined by MAR0-MAR7 are accepted
- 1 Runt Packets Accepted**
 - 0 Packets smaller than 64 bytes are rejected.
 - 1 Packets smaller than 64 bytes are accepted.
- 0 Error Packets Accepted**
 - 0 Reject Packets with CRC error
 - 1 Accept Packets with CRC error

Offset 7 - Transmit Configure Request.....RW

- 7-3 Reserved** R0
- 2-1 Transmit Loopback Mode**
 - 00 Normal
 - 01 Internal loopback (MAC only)
 - 1x Reserved
- 0 Reserved**R0

Offset 8 - Control 0RW

- 7-5 Reserved** always reads 0
- 4 Transmit Process**
 - 0 Transmit state disabled.....default
 - 1 Transmit DMA state enabled
- 3 Receive Process**
 - 0 Receive state disableddefault
 - 1 Receive DMA state enabled
- 2 Stop NIC**
 - 0 Command processing is in process
 - 1 Shut down NIC operationdefault
- 1 Start NIC**
 - 0 Command not entered.....default
 - 1 Enable NIC operation
- 0 Reserved** R0

Offset 9 - Control 1..... RW

- 7 Software Reset**
 - 0 Normal condition..... default
 - 1 Software reset (cleared after reset complete)
- 6 Receive Poll Demand Self Clearing**
 - 0 Toggle bit..... default
 - 1 Set 1 to poll the RD once. It will be cleared automatically after polling is completed.
- 5 Transmit Poll Demand Self Clearing**
 - 0 Toggle bit default
 - 1 Set 1 to poll the TD once, it will be cleared by itself after polling complete.
- 4 Reserved**always reads 0
- 3 Disable TD/RD Auto Polling**
 - 0 Set TX/RX auto-polling enable
 - 1 Set TX/RX auto polling disable default
- 2 Full Duplex**
 - 0 Set MAC to half duplex mode..... default
 - 1 Set MAC to full duplex mode
- 1 Disable Accept Unicast Packet**
 - 0 Accept the incoming packet destined to the VT6105 MAC Address..... default
 - 1 Reject the incoming packet destined to the VT6105 MAC Address
- 0 Reserved**R0

Offset 0C - ISR0..... RW

- 7 Reserved**always reads 0
- 6 PCI Bus Error**default is 0
- 5 Receive Descriptor Link Error**default is 0
- 4 Transmit Descriptor Structure Error** default = 0
- 3 Transmit Error**
 - 0 Packet transmission with no errors..... default
 - 1 Packet transmission is aborted due to
 - FIFO Underflow
 - Excessive collisions
 - PCI Bus error
 - TD structure error
- 2 Receive Error**
 - 0 Packets received with no errors..... default
 - 1 Packet received with the following errors:
 - FIFO Overflow
 - CRC error
 - Frame alignment error
 - RD structure error
- 1 Transmitted Packet Successful**default is 0
- 0 Received Packet Successful**default is 0

Offset 0D - ISR1..... RW

- 7 General Purpose Interrupt**.....default is 0
- 6 Port State Change**default is 0
- 5 Excessive Collision Transmit Abort**default is 0
- 4 RD running up**.....default is 0
- 3 Receive FIFO Queue List overflow**default is 0
- 2 Receive FIFO Overflow**default is 0
- 1-0 Reserved**always reads 0

Offset 0E - Interrupt Mask 0 (00h)RW

All bits correspond to the bits in the ISR0 register.

Offset 0F - Interrupt Mask 1 (00h).....RW

All bits correspond to the bits in the ISR0 register.

Offset 17-10 - Multicast AddressRW

63-0 Multicast Address Hash Table MAR0- MAR7

Offset 1B-18 - Receive Descriptor Base Address.....RW

31-0 Receive Descriptor List Starting Address

Offset 1F-1C - Transmit Descriptor Base AddressRW

31-0 Transmit Descriptor List Starting Address

Offset 6C - MII Configuration (MII_CFG).....RW

7-6 MII Management Polling Timer Interval

- 00 1024 Management Data Clock cycles.....default
- 01 512 Management Data Clock cycles
- 10 128 Management Data Clock cycles
- 11 64 Management Data Clock cycles

5 Accelerate Management Data Clock Speed

- 0 Management Data Clock=normaldefault
- 1 Management Data Clock=4X accelerating

4-0 Extend PHY Device Address

Store bytes from EEPROM loading during power up or EEPROM auto-reloading. The registers can be programmed by software. default is 00001

Offset 6D – MII Status (MIISR).....RW

- 7 Software PHY Reset default = 0**
- 6 Asm_Pause Status after N-WayRO**
- 5 Pause Status after N-WayRO**
- 4 Link Status after N-WayRO**
 - 0 Link Successdefault
 - 1 No cable connected
- 3 PHY Device Received ErrorRO**
- 2 Duplex Mode after N-WayRO**
 - 0 Half Duplexdefault
 - 1 Full Duplex
- 1 Link FailRO**
 - 0 Link Successdefault
 - 1 link failed
- 0 PHY SpeedRO**
 - 0 Speed is 100 Mbpsdefault
 - 1 Speed is 10 Mbps

Offset 6E – Bus Control 0 (BCR0)..... RW

- 7-6 Reservedalways reads 0**
- 5-3 Reserved.....always reads 0**
- 2-0 DMA Length**
 - 000 32 bytes (8 Double Words) default
 - 001 64 bytes (16 Double Words)
 - 010 128 bytes (32 Double Words)
 - 011 256 bytes (64 Double Words)
 - 100 512 bytes (128 Double Words)
 - 101 1024bytes (256 Double Words)
 - 11x Store & forward

Offset 6F – Bus Control 1 (BCR1)..... RW

- 7-3 Reservedalways reads 0**
- 2 Polling Time Interval 2.....default is 1**
- 1 Polling Time Interval 1default is 1**
- 0 Polling timer interval 0default is 0**

Offset 70 – MII Control (MIICR)..... RW

- 7 MII Management Port Auto Polling Enable**
 - 0 Disable default
 - 1 Enable
- 6 PHY Read EnableSelf-Clearing**
Reset when read is complete.
PHY Status is Stored in Rx72.
- 5 PHY Write EnableSelf-Clearing**
Reset when write is complete
- 4 Direct Programming Mode**
 - 0 Enable default
 - 1 Disable (R/W commands have no effect)
- 3 MDIO Output Enable Indicator**
- 2 Direct Programming Status as Management Port Data Out**
- 1 Direct Programming Input While Read PHY Status**
- 0 Direct Programming Status as Management Port Clock**

Offset 71 - Management Interface Address RW

- 7 MII Idle..... RO**
 - 0 MII auto polling cycle
 - 1 Not at MII auto polling cycle default
- 6 MII Status Change Enable**
 - 0 Open the Pause Function of MII Polling Cycle Done (MDONE)..... default
 - 1 Close the Pause Function of MDONE
- 5 MDONE**
When MDIO Auto Polling Data is Ready, MII State of SM is at the End of an Auto Polling Cycle
- 4-0 MII Management Port Address...default = 00001b**

Offset 73-72 - MII Read/Write Data Port RW

- 15-0 Data Scratch Field of Read Write Process on PHY Map Register**

Offset 74 – EEPROM Control/Status (EECSR).....RW

- 7 **EEPROM Programmed Status**RO
A value of 73H indicates programmed
- 6 **Reserved** always reads 0
- 5 **Dynamic Reload EEPROM Content**
- 4 **Direct Program EEPROM Mode**
- 3 **Direct Program EECS Chip Select Pin Status**
- 2 **Direct Program EECK Clock Pin Status**
- 1 **Direct Program EEDI Data In Pin Status**
- 0 **Direct Program EEDO Data Out Pin Status**.....RO

Offset 78 - Chip Configuration A (CFG A)RW

Note: This register always reads 00h after power is on and loading starts.

- 7 **EEPROM Embedded & Direct Programming**
 - 0 Disabledefault
 - 1 Enable
- 6 **MII Option**MIIOPT
 - 0 Without extension clockdefault
 - 1 With extension clock.
- 5 **Reserved** always reads 0
- 4-3 **LED Select**

	<u>LED0</u>	<u>LED1</u>	<u>LED2</u>	<u>LED3</u>
00	Link/Act	Speed	Duplex	COLdef
01	Pwr/TxAct	Link/RxAct	Speed	Duplex
10	Speed100	Speed10	Act	Duplex
11	Pwr/TxAct	Link/RxAct	Speed	COL
- 2 **Reserved** always reads 0
- 1 **Abnormal shut down wake up enable**
 - 0 Disable
 - 1 Enable.....default
- 0 **Pre-ACPI wake up enable**
 - 0 Disable.....default
 - 1 Enable

Offset 79 - Chip Configuration B (CFG B) RW

- 7 **Transmit Frame Queuing**
 - 0 Enable..... default
 - 1 Disable
- 6 **Data Parity Generation and Checking**
 - 0 Enable..... default
 - 1 Disable
- 5 **Memory Read Line Support**
 - 0 Enable..... default
 - 1 Disable
- 4 **Transmitting FIFO DMA Will Interleave to Receiving FIFO DMA after 32 DWORD Transaction**
- 3 **Arbitration Priority Select**
The TX FIFO DMA will be interleave to RX FIFO DMA after 32 DWORD transaction
- 2 **Master Read Insert One Wait State 2-2-2-2**
 - 0 Disable..... default
 - 1 Enable
- 1 **Master Write Insert One Wait State 2-2-2-2**
 - 0 Disable..... default
 - 1 Enable
- 0 **Latency Timer**
 - 0 Disable..... default
 - 1 Enable

Offset 7A - Chip Configuration (CFG C)..... RW

- 7 **Reserved** always reads 0
- 6 **Tie Unused Boot ROM Address MA High**
 - 0 Disable..... default
 - 1 Enable
- 5 **Delay Transaction During Boot ROM Read**
 - 0 Disable..... default
 - 1 Enable
- 4 **Reserved** always reads 0
- 3 **Boot ROM Timing Select**
 - 0 Fast default
 - 1 Slow
- 2-0 **Boot ROM Size Select**
 - 000 No Boot ROM default
 - 001 8K size
 - 010 16K size
 - 011 32K size
 - 1xx 64K size

Offset 7B - Chip Configuration D (CFG_D).....RW

- 7 Memory Mapped IO Access**
 - 0 Disabledefault
 - 1 Enabledefault
- 6 Diagnostic Mode**
 - 0 Disabledefault
 - 1 Enable
- 5 Reserved** always reads 0
- 4 Reserved for Test (Do Not Program)..... default = 0**
- 3 Random Backoff Algorithm**
 - 0 Disabledefault
 - 1 Enable
- 2-0 Reserved for Test (Do Not Program)..... default = 0**

Offset 80 - Miscellaneous Control (CR0).....RW

- 7-5 Reserved** always reads 0
- 4 Transmit Full-Duplex Flow Control**
 - 0 Disabledefault
 - 1 Enable
- 3 Receive Full-Duplex Flow Control**
 - 0 Disabledefault
 - 1 Enable
- 2 Half-Duplex Flow Control**
 - 0 Disabledefault
 - 1 Enable
- 1 Timer 0 Suspend Write 0 to Clear**
 - 0 Software Timer 0 will continue to count
 - 1 Software Timer 0 Timeout (set by hardware)
- 0 Software Timer 0 Count Enable.....RW**
 - 0 Disabledefault
 - 1 Enable

Offset 81 - Miscellaneous Control (CR1).....RW

- 7 Software Generated Suspend Reset**
 - 0 Disabledefault
 - 1 Enable
- 6 Force Exit Software Stop Without Waiting For Safestate**
 - 0 Disabledefault
 - 1 Enable
- 5 Reserved** always reads 0
- 4 Power Management Unit Support Version 1.0**
 - 0 Disabledefault
 - 1 Enable
- 3 Reserved** always reads 0
- 2 Soft-Timer Resolution in Micro-Seconds**
 - 0default
 - 1
- 1 PHY Event Interrupt Passed through INTA#**
 - 0 Disabledefault
 - 1 Enable
- 0 Software Timer 1 Count Enable**
 - 0 Disabledefault
 - 1 Enable

Offset 82 - Power Mgmt Capability Control (PMCC)....RO

- 7-0 EEPROM Power Mgmt Capability Shadow**

Offset 83 – Sticky Hardware Control (STICKHW)..... RW

- 7-4 Reserved**always reads 0
- 3 Legacy WOL Status**
 - 0 Disable..... default
 - 1 Enable
- 2 Legacy WOL Enable**
 - 0 Disable..... default
 - 1 Enable
- 1 Sticky DS1_Shadow Read-Write by Software**
- 0 Sticky DS0_Shadow Suspend Well DS Write Port**

Offset 84 – MISC Interrupt Status (MISR)..... RW

- 7 Power Event Report in Test Mode**
- 6 User Defined Host Driven Interrupt**
- 5 User Defined Host Driven Interrupt**
- 4 Suspend Well MII Polling Status Change Interrupt by Diagnosis Use**
- 3 Reserved**always reads 0
- 2 PHY Event Interrupt**
- 1 Software Timer 1 Interrupt**
- 0 Software Timer 0 Interrupt**

Offset 86 – MISC Interrupt Mask (MIMR)..... RW

- 7 Power Event Report in Test Mode Mask**
- 6 User Defined Host Driven Interrupt Mask**
- 5 User Defined Host Driven Interrupt Mask**
- 4 Suspend Well MII Polling Status Change Interrupt By Diagnosis Use Mask**
- 3 TD Internal Error Interrupt Mask**
- 2 PHY Event Interrupt Mask**
- 1 Software Timer 1 Interrupt Mask**
- 0 Software Timer 0 Interrupt Mask**

Offset 8D-8C - Flash Programming Address..... RW

- 15-0 Flash ROM Embedded Programming Address**

Offset 8F - Flash Embedded Write Data Port RW

- 7-0 Flash ROM Embedded Write Data Port**

Offset 90 - Flash Control Status..... RW

- 7 Flash Embedded Programming Complete**
 - 0 Not Complete default
 - 1 Complete
- 6-2 Reserved**always reads 0
- 1 Flash Embedded Write Command**
 - 0 Normal operation..... default
 - 1 Initiate Write Command
- 0 Flash Embedded Read Command**
 - 0 Normal operation..... default
 - 1 Initiate Read Command

Note: Bit 7 is set after the embedded command is completed. Write operations are not allowed in normal operation.

Offset 91 - Flash Read Data..... RW

- 7-0 Flash ROM Embedded Read Data Port**

Offset 98 - Flow Control 0 (CR0).....RW

This register is used for flow control.

- 7-0 Receive Buffer Count Available for Incoming Packet**

Offset 99 - Flow Control 1 (CR1).....RW

- 7-6 Transmit Pause Frame Low Threshold**
 - 00 4 free Receive Buffer left
 - 01 8 free Receive Buffer left
 - 10 16 free Receive Buffer left
 - 11 24 free Receive Buffer left.....default
- 5-4 Transmit XON Pause Frame High Threshold**
 - 00 24 free Rx Buffer left
 - 01 32 free Receive Buffer left
 - 10 48 free Receive Buffer left.....default
 - 11 64 free Receive Buffer left
- 3 Xon/Xoff Mode in Flow Control**
 - 0 Disabledefault
 - 1 Enable
- 2 Full Duplex Flow Control on Transmit Side**
 - 0 Disabledefault
 - 1 Enable
- 1 Full Duplex Flow Control on Receive Side**
 - 0 Disabledefault
 - 1 Enable
- 0 Half-Duplex Flow Control**
 - 0 Disabledefault
 - 1 Enable

Offset 9B-9A - Pause Frame TimerRW

- 15-0 Pause_Timer Value in Outgoing Pause Frame**

Offset 9D-9C - Software Timer 0.....RW

- 15-0 Software Timer with Single Shot**

Offset 9F-9E - Software Timer 1RW

- 15-0 Software Timer with Periodic Shot**

Offset A0/A4 – Wake On LAN Set/Clear RW

- 7 Wake Up Event Detect Network Status Change from Link On to Link Off**
 - 0 Disable..... default
 - 1 Enable
- 6 Wake Up Event Detect Network Status Change from Link Off to Link On**
 - 0 Disable..... default
 - 1 Enable
- 5 Wake Up Event Detect Magic Packet**
 - 0 Disable..... default
 - 1 Enable
- 4 Wake Up Event Detect Unicast Packet**
 - 0 Disable..... default
 - 1 Enable
- 3 Wake Up Event Detect Pattern 3**
 - 0 Disable..... default
 - 1 Enable
- 2 Wake Up Event Detect Pattern 2**
 - 0 Disable..... default
 - 1 Enable
- 1 Wake Up Event Detect Pattern 1**
 - 0 Disable..... default
 - 1 Enable
- 0 Wake Up Event Detect Pattern 0**
 - 0 Disable..... default
 - 1 Enable

Offset A1/A5 - Power Configuration Set/Clear (PWCFG SET/PWCFG CLR)..... RW

- 7 PHY Power Down Option default = 0**
- 6 Internal Sticky Logic Control always write 0**
- 5 WOL Pin Signaling Control**
 - 0 Pulse
 - 1 Button..... default
- 4 Legacy Wake On LAN**
- 3 PCI_CFG_PME_SR Shadow**
- 2 PCI_CFG_PME_EN Shadow**
- 1 Legacy WOL_SR Shadow**
- 0 Legacy WOL_EN Shadow**

Offset A2/A6 Wake On LAN Set/Clear.....RW

- 7-4 **Reserved** always reads 0
- 3 **LED off enable**
 - 0 Disabledefault
 - 1 Enable
- 2 **Reserved**
- 1 **Wake-Up Event: Detect Pattern 4**
 - 0 Disabledefault
 - 1 Enable
- 0 **Wake-Up Event: Detect Pattern 5**
 - 0 Disabledefault
 - 1 Enable

Offset A3/A7 – WOL Configuration Set/ClearRW

- 7 **Power Management Over**PME_OVR
Forces Power Management Event Enable (PME_EN)
for Legacy Use
 - 0 Disabledefault
 - 1 Enable
- 6 **Shadow Full Duplex Control in Suspend Wake On LAN Logic**
 - 0 Disabledefault
 - 1 Enable
- 5 **Shadow Accept Multicast Address Control in Suspend Wake On LAN Logic**
 - 0 Disabledefault
 - 1 Enable
- 4 **Shadow Accept Broadcast Address Control In Suspend Wake On LAN Logic**
 - 0 Disabledefault
 - 1 Enable
- 3 **Reserved (Do Not Program)** default = 0
- 2 **Reserved** always writes 0
- 1 **Reserved (Do Not Program)** default = 0
- 0 **Reserved** always writes 0

Offset A8/AC – Wake-On-LAN Status 0RWC

- 7 **Wake Up Event Status - Network Status Change from Link On to Link Off**
- 6 **Wake Up Event Status - Network Status Change from Link Off to Link On**
- 5 **Wake Up Event Status - Magic Packet Filter**
- 4 **Wake Up Event Status - Unicast Packet Filter**
- 3 **Wake Up Event Status - Pattern 3 Filter**
- 2 **Wake Up Event Status - Pattern 2 Filter**
- 1 **Wake Up Event Status - Pattern 1 Filter**
- 0 **Wake Up Event Status - Pattern 0 Filter**

Offset BF-B0 - WOL Pattern Match CRC DataRW

Offset CF-C0 - WOL Pattern Match Byte Mask 0RW

Offset DF-D0 - WOL Pattern Match Byte Mask 1RW

Offset EF-E0 - WOL Pattern Match Byte Mask 2.....RW

Offset FF-F0 - WOL Pattern Match Byte Mask 3RW

PHY Registers

Offset 0 - MI Control (3100h)..... RW

- 15 **PHY Reset** default = 0
(Software Control)
- 14 **Loopback Mode**
 - 0 Disable..... default
 - 1 Enable
- 13 **Speed Select LSB**
 - 0 10
 - 1 100 default
- 12 **Auto-Negotiation Process**
 - 0 Disable
 - 1 Enable..... default
- 11 **Power Down**
 - 0 Disable..... default
 - 1 Enable
- 10 **Electrically Isolate PHY from MII**
 - 0 Disable..... default
 - 1 Enable
- 9 **Auto-Negotiation Restart** default = 0
(Software Control)
- 8 **Duplex Mode Select**
 - 0 Half
 - 1 Full default
- 7 **COL Test**
 - 0 Disable..... default
 - 1 Enable
- 6-0 **Reserved**always reads 0

Offset 1 – Management Information Status (7849h)..... RO

- 15 **Capable of 100 Base-T4 Operation**..... default=0
- 14 **Capable of 100 Base-TX Full Duplex** default=1
- 13 **Capable of 100 Base-TX Half Duplex** default=1
- 12 **Capable of 10 Base-TX Full Duplex** default=1
- 10-7 **Reserved** always reads 0
- 6 **Capable of Accepting MI Frames with MI Preamble Suppressed**..... default=1
- 5 **Auto-Negotiation Process Completed**..... default=0
- 4 **Remote Fault Condition Detected**..... default=0
- 3 **Capable of Auto-Negotiation Operation** . default=1
- 2 **Link Status** default=0
- 1 **Jabber Condition Detected**..... default=0
- 0 **Capable of Extended Register**..... default=1

Offset 2 – PHY Identifier 0 (0101h)..... RO

- 15-0 **Company ID MSBs** always reads 0101h

Offset 3 – PHY Identifier 1 (8F43h)..... RO

- 15-10 **Company ID LSBs**always reads 8Fh
- 9-4 **Manufacturer’s Part number** always reads 43h
- 3-0 **Manufacturer’s Revision Number** always reads 0

Offset 4 (04h) – AutoNegotiation Advertisement Base Page (05E1h).....RW

- 15 Next Page default = 0
- 14 Acknowledge RO, default = 0
- 13 Remote Fault default = 0
- 12-11 Reserved always reads 0
- 10 Flow Control default = 1
- 9 100 Base-T4 Capable default = 0
- 8 100 Base-TX Full Duplex Capable default = 1
- 7 100 Base-TX Half Duplex Capable default = 1
- 6 10Base-TX Full Duplex Capable default = 1
- 5 10Base-TX Half Duplex Capable default = 1
- 4-0 Protocol Select default = 00001b

Offset 5 (05h) –Auto Negotiation Link Partner Base Page Ability (0000h).....RO

- 15 Next Page Indication default = 0
- 14 Acknowledge default = 0
- 13 Remote Fault default = 0
- 12-10 Reserved always reads 0
- 9 100 Base-T4 Capable default = 0
- 8 100 Base-TX Full Duplex Capable default = 0
- 7 100 Base-TX Half Duplex Capable default = 0
- 6 10 Base-TX Full Duplex Capable default = 0
- 5 10 Base-TX Half Duplex Capable default = 0
- 4-0 Protocol Select default = 0

Offset 6 (06h) – Auto-Negotiation Expansion (0004h)....RO

- 15-5 Reserved always reads 0
- 4 Parallel Fault Detect in Auto-Negotiation Process default = 0
- 3 Link Partner Capable of Next Page Process . def=0
- 2 Capable of Next Page Process..... default = 0
- 1 Page Received in Auto-Negotiation Process default = 0
- 0 Link Partner Capable of Auto-Negotiation Process default = 0

Offset 7 (07h) – AutoNegotiation Advertisement Next Page (2001h).....RW

- 15 Next Page default = 0
- 14 Reserved always reads 0
- 13 Message Page default = 1
- 12 Acknowledge default = 0
- 11 Toggle Bit RO, default = 0
- 10-0 Message Code Field or Unformatted Code Field default = 001h

Offset 8 (08h) – Link Partner Advertisement Next Page (0000h).....RO

- 15 Next Page default = 0
- 14 Received Code Word Recognized default = 0
- 13 Message Page default = 0
- 12 Capable of Complying with Message default = 0
- 11 Toggle Bit default = 0
- 10-0 Message Code Field or Unformatted Code Field ... default = 0

Offset 10h – PHY Configuration 1 (0800h)..... RW

15-11 PHY Address RO

- 10 Fiber Mode
 - 0 Disable default
 - 1 Enable
- 9 SIP Mode Select RO
 - 0 Disable default
 - 1 Enable
- 8 Force Link RO
 - 0 Disable default
 - 1 Enable
- 7 Base 10 Low Squelch Level Select RO
 - 0 Disable default
 - 1 Enable

6-5 Programmable LED Output Select

	LED0	LED1	LED2	LED3
00	Link/Act	Speed	Duplex	COL.... def
01	Pwr/TxAct	Link/RxAct	Speed	Duplex
10	Speed100	Speed10	Act	Duplex
11	Pwr/TxAct	Link/RxAct	Speed	COL

- 4 Repeater Mode RO
- 3 PHYINT Output Select
 - 0 PHYINT default
 - 1 MDIO
- 2 Symbol Mode
 - 0 Disable default
 - 1 Enable
- 1 Reserved always reads 0
- 0 nWay Force Mode RW, default = 0

Offset 11h - PHY Configuration 2 (F7FFh).....

- 15 Jabber Detect
 - 0 Disable
 - 1 Enable default
- 14 Signal Quality Error Detect
 - 0 Disable
 - 1 Enable default
- 13 Auto-Polarity Enable
 - 0 Disable
 - 1 Enable default
- 12 Far End Fault Enable
 - 0 Disable
 - 1 Enable default
- 11 Change Seed of Scrambler Self Clearing
 - 0 Disable default
 - 1 Enable
- 10-0 New Seed default = 7FFh

Offset 12h – PHY Configuration 3 (0800h)RW

- 15 Bypass Scrambler and Descrambler Functions**
 - 0 Disabledefault
 - 1 Enable
- 14 Bypass 4B5B Encoding and Decoding Functions**
 - 0 Disabledefault
 - 1 Enable
- 13 Bypass Symbol Alignment Function**
 - 0 Disabledefault
 - 1 Enable
- 12 Bypass NRZI Encoding and Decoding Functions**
 - 0 Disabledefault
 - 1 Enable
- 11 Loss Sync Function..... Self Clearing**
 - 0 Disable
 - 1 Enabledefault
- 10 Lost Sync Timer Select**
 - 0 722 usecdefault
 - 1 2 msec
- 9-0 Reserved** always reads 0

Offset 13h – PHY Interrupt Mask (FFFCh) RW

- 15 Mask Interrupt Function**
 - 0 Disable
 - 1 Enable..... default
- 14 Mask Interrupt on Link-Up Status**
 - 0 Disable
 - 1 Enable..... default
- 13 Mask Interrupt on Link-Fail Status**
 - 0 Disable
 - 1 Enable..... default
- 12 Mask Interrupt on Link Status Change**
 - 0 Disable
 - 1 Enable..... default
- 11 Mask Interrupt on Auto-Negotiation Process Complete**
 - 0 Disable
 - 1 Enable..... default
- 10 Mask Interrupt on Page Received in Auto-Negotiation Process**
 - 0 Disable
 - 1 Enable..... default
- 9 Mask Interrupt on Jabber Condition Detect**
 - 0 Disable
 - 1 Enable..... default
- 8 Mask Interrupt on Invalid Symbol Received**
 - 0 Disable
 - 1 Enable..... default
- 7 Mask Interrupt on SSD Delimiter Error Detected**
 - 0 Disable
 - 1 Enable..... default
- 6 Mask Interrupt on ESD Delimiter Error Detected**
 - 0 Disable
 - 1 Enable..... default
- 5 Mask Interrupt on Signal Quality Error Detected**
 - 0 Disable
 - 1 Enable..... default
- 4-2 Reserved (Do Not Program)..... default = 111b**
- 1-0 Reserved** always reads 0

Offset 14h – PHY Status (0000h).....RO

- 15 Polarity Inversion Base10-Tx**
 - 0 Disabledefault
 - 1 Enable
- 14 Link Up Status** default = 0
- 13 Link Fail Status**..... default = 0
- 12 Link Status** default = 0
- 11 Auto-Negotiation Process Complete** default = 0
- 10 Page Received in Auto-Negotiation Process**
..... default = 0
- 9 Jabber Condition Detect** default = 0
- 8 Error Code Symbol Received** default = 0
- 7 Start of Stream Delimiter Error**..... default = 0
- 6 End of Stream Delimiter Error** default = 0
- 5 Signal Quality Error Detected**..... default = 0
- 4-2 Reserved (Test Status)**..... default = 000b
 - 1 PHY Speed Status**..... default = 0
 - 0 PHY Duplex Status**..... default = 0

Offset 19h – Power Control.....RW

- 15-8 Reserved** always reads 0
- 7 Power Saving Status**
 - 0 Low Power Enable.....default
 - 1 Force Power Saving Mode
- 6-0 Reserved** always reads 0

FUNCTIONAL DESCRIPTIONS

The VT6105 PCI bus master 10/100 Mbps fast Ethernet controller is a CMOS VLSI chip designed for easy implementation in CSMA/CD IEEE 802.3u 10/100 Mbps Ethernet networks. Significant features include: twisted-pair wiring interface, Plug and Play compatibility, 32-bit bus mastering and powerful system buffer management. .

The VT6105 integrates the entire bus interface of PCI systems, complying with PCI Specification v2.1 and v2.2. The VT6105 supports the on-chip 100Base-TX layer transceiver.

Host Bus Interface Control Logic

PCI Master Function

The VT6105 supports a descriptor-based communication list between hardware and software on both transmitting and receiving signals. The DMA scheduler fetches the transmit and receive descriptors via PCI bus mastering to check if free buffers are available to store receive packets and scheduled transmission requests.

Data transfer between the system buffers and internal FIFOs in the VT6105 are executed by the internal PCI DMA controller using a bus mastering linear bursting scheme. An advanced internal bus arbitration scheme is implemented to improve bus utilization and service priorities.

The VT6105 also supports a Look Ahead Scheduler which queues multiple transmit frames for back-to-back transmission service.

When receive or transmit processes are complete, the VT6105 writes back the transfer and network status to the indexed descriptors to release descriptor ownership.

PCI Slave Function

VT6105 supports PCI slave-register I/O and memory-mapped I/O cycles for command and status registers, PCI configuration cycles for Plug & Play BIOS and memory-read cycles for Boot ROM code shadowing.

Buffer Management

The VT6105 hardware controller and drivers communicate through two data structures:

1. Control and status register (CSR)
2. Descriptor entries and data buffers

During initialization, the drivers create the structure of the Transmit and Receive descriptors in physical memory and decide the base address for the Receive and Transmit descriptor rings, which are written to registers CSR6 (Current Receive Descriptor Address) and CSR7 (Current Transmit Descriptor Address) respectively. The number of entries contained in the descriptor rings and the buffers reserved in physical memory for Receive and Transmit descriptors are set up during initialization.

Each of the descriptor entries must occupy a contiguous area of memory. The Receive (Transmit) Descriptor DMA register of the CSR also keeps the content of the current and next Receive and Transmit Descriptor.

Simple Ring Buffer Structure

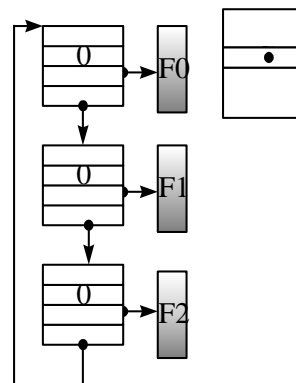


Figure 3. Buffer Structure

For Reception, when the data packets in the receive FIFO are transferred to system memory, the controller will proceed to write back the current packet reception status to the receive descriptor and then update the transmission interrupt status in the ISR.

When transmitting data, the controller starts the DMA cycle and brings the data from memory to the Tx FIFO register and updates the status information of the Transmission Descriptor DMA Register after transmission is complete. The controller then proceeds to write back to the descriptor in memory using another DMA cycle.

Receive Descriptor Packet Layout (RD)

The Receive Descriptor packet layout provides a data buffer address, byte-count, and a next descriptor address. The chain bit allows data storage to span multiple data buffers and is compatible with various types of memory-management schemes.

	31	30-16	0-15
RDES0	0	Rx Length Field	RSR
RDES1	Reserved		Rx_Buffer_Size
RDES2	Rx_Buffer_Start_Address		00
RDES3	Next_Rx_Desc_Address		

Figure 4. Receive Descriptor Packet Layout

The Receive Descriptor Layout consists of four levels of data: RDES0, RDES1, RDES2, and RDES3.

Table 5. Receive Descriptor 0 (RDES0)

Bit	Symbol	Description
31	OWN	Owner. This bit is controlled by the driver, which enables the bit when initialized. 1 indicates that a descriptor is free for the VT6105 to use. 0 means this descriptor is being used by the VT6105.
16-30	Rx_Length_Field	Receive Length
15-8	Receive Status Register	
15	RXOK	No Receive Errors
14		-reserved-
13	MAR	Accept Multicast Address Packets
12	BAR	Accept Broadcast Address Packets
11	PHY	Accept Physical Address Packets
10	CHN	Chain Buffer - Always = "1"
9	STP	Packet Start - This occurs in the Descriptor ring structure: STP=1 EDP=1 - Single buffer; STP=1 EDP=0 - Another buffer chained; STP=0 EDP=1: Packet end indication; STP=0 EDP=0 - invalid setting
8	EDP	Packet End Indication
7	BUFF	Descriptor Link Structure Error
6		-reserved-
5	RUNT	Runt Package Received: length < 64 bytes
4	LONG	Long Package Received: length > 1518 bytes
3	FOV	FIFO Overflow
2	FAE	Frame Align Error
1	CRCE	CRC Error: receive frame checksum error
0	RERR	Receive Error: RERR = CRCE FAE FOV BUFF SERR

Table 6. Receive Descriptor 1 (RDES1)

Bit	Symbol	Description
31-15	RSV	-reserved-
14-11	Rx_Buffer_Size	Receive Buffer Size always reads 0
10-0	Rx_Buffer_Size	-reserved-

Table 7. Receive Descriptor 2 (RDES2)

Bit	Symbol	Description
31-2	Rx_Buffer_Start_Address	Register Buffer Start Address Double word alignment (bits 1:0 always 00b)

Table 8. Receive Descriptor 3 (RDES3)

Bit	Symbol	Description
31-2	Next_Rx_Desc_Address	Next Register Descending Address Next linked descriptor address

Transmit Descriptor Packet Layout (TD)

The Transmit Descriptor packet layout provides a data buffer address, byte-count, and a next descriptor address. The chain bit allows data storage to span multiple data buffers and is compatible with various types of memory-management schemes.

	31	30-16	15-0
TDES0	0	Reserve	TSR
TDES1	Reserved	TCR	Tx_Buffer_Size
TDES2	Tx_Buffer_Start_Address		
TDES3	Next_Tx_Desc_Address		

Figure 5. Transmit Descriptor Packet Layout

The Transmit Descriptor Layout consists of four levels of data: TDES0, TDES1, TDES2, and TDES3.

Table 9. Transmit Descriptor 0 (TDES0)

Bit	Symbol	Description
31	OWN	Owner. This bit is controlled by the driver. 1 indicates that a Transmit request is scheduled. 0 means this descriptor is used by VT6105. The driver must enable this bit when initialized.
16-30	-reserved-	-reserved-
15-0	TSR	Transmit Status Register
	15-0	TERR Transmit Error 0: Tx successfully 1: ABT (for definitions see entries in this table)
	14-11	-reserved- -reserved-
	10	CRS Carrier Sense Lost Detect
	9	OWC Out of Window Collision
	8	ABT Excessive collision Tx abort
	7	CDH CD Heartbeat Check Failure (valid in 10Base-T mode)
	6-5	-reserved- -reserved-
	4	COLS Collision Detect
	3-0	NCR Number of Collision Retries

Table 10. Transmit Descriptor 1 (TDES1)

Bit	Symbol	Description
31-24	TCR	Transmit Control Register.
23-16	Tx_Control_Fie ld	Transmit Control Field
23	IC	Interrupt Control 0: No interrupt when Transmit OK 1: Interrupt when Transmit OK
22	STP	Packet Start , in Descriptor ring structure STP=1 EDP=1 - single buffer per packet STP=1 EDP=0 - packet segment STP=0 EDP=1 - packet end indication STP=0 EDP=0 - invalid setting
21	EDP	Packet End Indication
20-17	-reserved-	-reserved- (must always be " 0")
16	CRC	Disable CRC Generation
15	CHN	Chain Structure 1 Indicates a chain structure 0 indicates a ring structure.
14-11	Tx_Buffer_Size	Transmit Buffer Size Always reads 0
10-0	Tx_Buffer_Size	Transmit Buffer Size Always reads 0

Table 11. Transmit Descriptor 2 (TDES2)

Bit	Symbol	Description
31-0	Tx_Buffer_ start_address [31:0]	Transmit Buffer Start Address Byte-oriented transmit data buffer starting address

Table 12. Transmit Descriptor 3 (TDES3)

Bit	Symbol	Description
31-2	Next_Tx_ Desc_Address [31:2]	Next Transmit Descriptor Address Next linked transmit descriptor start address

FIFO and Control Logic

The VT6105 incorporates two independent deep FIFOs for data that is transmitted and received between the system interface and the network interface. The FIFOs provide temporary data storage and frees the host system from the real-time demands of the network.

The VT6105 implements enhanced receive FIFO management logic to handle multiple received data packets that are transferred to the system data buffer. This ability can reduce packet loss due to PCI bus mastering arbitration latency. The PCI bus mastering arbitration latency is the time from a request issued by the master to the request really performed on the PCI bus.

Network Interface

The VT6105 controller supports 100Base-TX and 100Base-FX transceivers, and provides an independent 10/100 BaseT transceiver interface to an external 1:1 magnetic transceiver.

100BaseT Transceiver Auto MDI/MDIX Configuration Function

The VT6105 supports MDI/MDIX functions for user-friendly installation of switch hubs, peer-to-peer PCs, cable modems, and ADSL modems with crossover TP usage.

LED Status and PHY Force Fiber Mode Strapping

VT6105 network status information is available on four LED output pins. The LEDs reflect network status per the “LED Select” bits in PHY register Rx10[6:5] and can be set up to indicate various status functions such as the transmit, receive and collision activities, link status, and link polarity. LED Function Definition is summarized in Table 13 below.

Table 13. LED Status

LEDSEL	LED0 (Blinking)	LED1	LED2	LED3
00	Link/Active	Speed	Duplex	COL
01	Power/TxAct	Link/RxAct	Speed	Duplex
10	Spd100	Spd10	Active	Duplex
11	Power/TxAct	Link/RxAct	Speed	COL

EEPROM Interface

EEPROM Direct Programming

The VT6105 features an easy way to program the external serial EEPROM directly. Setting EELOAD (Rx78[7]) and DPM (Rx74[4]) make the VT6105 enter Direct Programming Mode. In this mode the user can directly control the EEPROM interface signals by writing to the EECSR register (Rx74). EECS (bit 3), EESK (bit 2), and EEDI (bit 1) will be driven onto the EECS, EESK, and EEDI pins respectively. These outputs will be latched so the user can generate the EEPROM interface signals per the 93C46 data sheet.

To read EEPROM data, the EEPROM interface must generate signals onto the EECS, EESK, and EEDI pins at the same time as data is read from the EEDO input via the EEDO bit (bit 0). Reading the EEDO bit during programming will not affect the latched data on the EECS, EESK, and EEDI outputs. When the EEPROM has been programmed and verified (including the lower byte of 0Fh with 73h), the VT6105 must be reset to return to normal operation and read in the new data.

Direct Programming Mode is mainly used for production to program every bit of the EEPROM. Once the lower byte of 0Fh has been programmed with 73h and a power-on reset has been performed, EEPR (Rx74[7]) will be set so the contents of the EEPROM may not be changed.

EEPROM Embedded Programming

If the upper byte of 0Fh of the serial EEPROM has been programmed to 73h when the VT6105 is loading the EEPROM data during power-on reset, the EEPR bit of Signature Register will be set to prohibit Direct Programming mode. However, configuration registers A, B, and C are programmed using Embedded Programming mode by following the routine specified in the example code below. This operation will work regardless of the value of EECONFIG. The setting of the EELOAD bit of Configuration Register B starts the EEPROM write process. Care should be taken not to accidentally modify the “polarity” (POL) and “good link” (GDLNK) bits because these two bits return the value indifferent from the setting. This programming process is ended when the EELOAD bit goes to zero.

```

EEPROM_EMB_PROG ( )
{
    // defined constant:
    CONFIG_B, EELOAD
    // declared register: value,
    config_for_A, config_for_B,
    config_for_C
    // declared function:
    DISABLE_INTERRUPTS,
    ENABLE_INTERRUPTS, READ, WRITE, WAIT
    DISABLE_INTERRUPTS ( );
    value = READ (CONFIG_B);
    value = value | EELOAD;
    WRITE (CONFIG_B, value);
    READ (CONFIG_B);
    WRITE (CONFIG_B,
config_for_A);
    WRITE (CONFIG_B,
config_for_B);
    WRITE (CONFIG_B,
config_for_C);
    while (value || EELOAD)
    {
        value = READ (CONFIG_B);
        WAIT ( );
    }
    ENABLE_INTERRUPTS ( );

```


EEPROM Contents

The VT6105 supports a 93C46 external Serial ROM, which may be used, when a BootROM is not used, to store the Ethernet ID, sub-vendor ID, and chip configurations (listed in Table 14 below):

Table 14. Chip Configuration EEPROM Contents

Offset ID	Chip Configuration	
	Bit [15:8]	Bit [7:0]
00h	Ethernet Global ID [15:8]	Ethernet Global ID [7:0]
01h	Ethernet Global ID [31:24]	Ethernet Global ID [23:16]
02h	Ethernet Global ID [47:40]	Ethernet Global ID [39:32]
03h	Reserved (always 00h)	Reserved (always 00h)
04h	PCI Configuration Sub-System ID [15:0]	PCI Configuration Sub-System ID [7:0]
05h	PCI Configuration Sub-Vendor ID [15:0]	PCI Configuration Sub-Vendor ID [15:0]
06h	Reserved (always 00h)	Reserved (always 00h)
07h	Reserved (always 00h)	Reserved (always 00h)
08h	Reserved (always 00h)	PCI Power Management Capability Setting
09h	Reserved (always 00h)	Reserved (always 00h)
0Ah	Reserved (always 00h)	Reserved (always 00h)
0Bh	PCI Configuration Maximum Latency Setting	PCI Configuration Minimum Grant
0Ch	Bus Control Register 1	Bus Control Register 0
0Dh	Chip Configuration B	Chip Configuration A
0Eh	Chip Configuration D	Chip Configuration C
0Fh	Checksum	73 h

The “Power Management Capability Setting” byte includes the following:

- Bit-0: D0_En - D0 state capable
- Bit-1: D1_En - D1 state capable
- Bit-2: D2_En - D2 state capable
- Bit-3: D3h_En - D3 hot state capable
- Bit-4: D3c_En - D3 Aux power state capable
- Bit-5: D1_Dis - Disable D1 state support
- Bit-6: D2_Dis - Disable D2 state support
- Bit-7: DSI - DSI in PMU register

Interrupt Control

Either in Transmit or Receive side, The interrupt generation is packet-based. Normally, the interrupt will be issued as a whole packet served (transmitted or received). Sometimes, to reduce system loading, the interrupt(s) is allowed to be triggered as multiple frames served.

Flow Control

The VT6105 is Jam based in half-duplex and supports the IEEE 802.3x flow control scheme while in full duplex. This occurs when the VT6105 detects the receive buffers or when the external FIFO is running up.

In half duplex mode, the MAC sends jam patterns automatically when the addressed packets are stopping transmission from the source station. In full duplex mode, the VT6105 will generate a Pause control frame to inform the source station to stop transmission for a specified period of time defined in the Pause frame. After the busy condition is clear, the VT6105 will send another Pause control frame with pause_time (0000h) to inform the source station to prepare packet reception.

The VT6105 also implements detection logic to filter incoming pause control frames. When a valid Pause control frame is detected, the VT6105 enters the Backoff state after the current transmission is completed and waits for the specified period of time defined in the received Pause frame to operate. The VT6105 will retransmit other packets in the transmit queue after receiving a new pause frame with pause_time (-0000h) or when the pause timer has expired.

Also, IEEE 802.3x flow control capability results from N-Way auto-negotiation and can be optionally disabled.

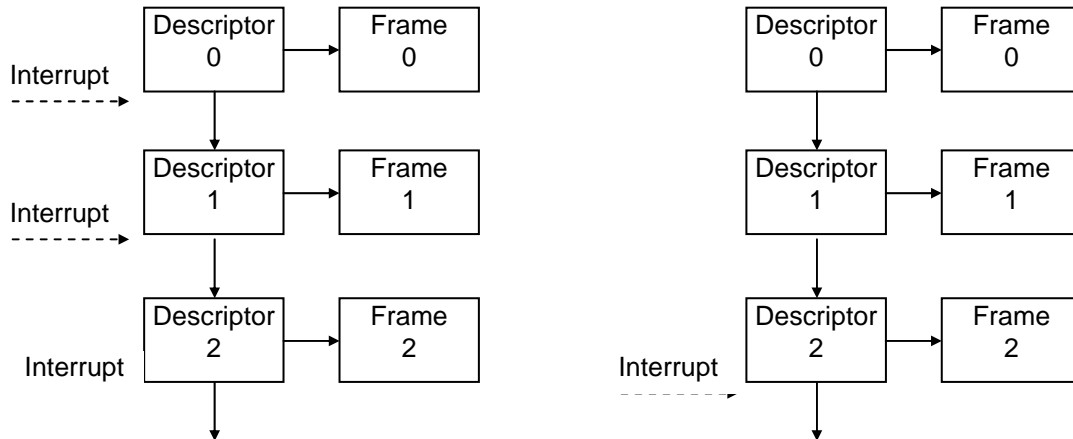


Figure 6. Interrupt Control

Power Management

The VT6105 is compliant with ACPI V1.0, PCI Power Management V1.1 and Network device class power management V1.0a specifications. It meets the PC97/PC98/PC99/PC2001 and net PC requirements. VT6105 can wake up a system in power-down mode. Using four wake-up events, VT6105 wakes up a system via the PME# and restores the system to its running state.

Wake-up Events

- **Link Status Change:** If the link state is either connect or disconnect, PME# is generated when the link state changes
- **Magic Packet:** When the VT6105 is set to magic packet mode, it requires that a received packet qualify as a Magic Packet
- **Magic Packet Pattern:** The Magic packet pattern (six FFh bytes + 16 times Source Address duplication) matches the destination address of the received magic packets. The Magic register (RxA0[5]) is set to enabled and the VT6105 will receive the packet.
- **Unicast Physical Address Match:** When the VT6105 is set to Unicast mode, it requires a received packet to qualify as a unique individual address. The Unicast register bit (RxA0[5]) is set to enabled and the VT6105 will receive the packet.
- **MS-Defined Pattern Match:** When the stations shut down after an operating system is loaded, the IP address, station name or other defined values are set by the drivers to VT6105
 - IP (ARP)
 - Name Query
 - NET BIOS
 - VIA defined

Table 15. Power States

VT6105 Device State	Conditions	I_ PCI mA	I_ AUX mA	Action from Function
D0	PCI = 33MHz, MAC = 25MHz, Tx, Rx Active	28	11	Full function
D1, D2	PCI = 33MHz, MAC = 25MHz, PCI bus transaction Idle	18	9	Wake up event detection
D3 hot	PCI Clock Idle, MAC = 25MHz, Tx off, Rx on	9	8	Wake up event detection
D3 cold	PCI power off, MAC = 25MHz, Tx off, Rx on	9	8	Wake up event detection

ELECTRICAL SPECIFICATIONS

Absolute Maximum Ratings

Table 16. Absolute Maximum Ratings

Symbol	Parameter	Min	Max	Unit	Comment
T _S	Storage Temperature	-55	125	° C	
T _C	Case Operation Temperature	0	110	° C	
T _A	Ambient Temperature	0	70	° C	
V _{CC33}	3.3V I/O Supply Voltage	V _{CC33} - 0.165	V _{CC33} + 0.165	Volts	3.3 V
V _{CC25}	2.5V Core Voltage	V _{CC25} - 0.125	V _{CC25} + 0.125	Volts	2.5 V
V _{CCA}	2.5V Analog Voltage	V _{CCA} - 0.125	V _{CCA} + 0.125	Volts	2.5 V
V _{CCR}	2.5V Internal Core Voltage	V _{CCR} - 0.125	V _{CCR} + 0.125	Volts	2.5 V
—	ESD Rating	—	2500	Volts	

Note: Stress above the conditions listed may cause permanent damage to the device. Functional operation of this device should be restricted to the conditions described under operating conditions.

DC specifications

T_C = 0-70° C, V_{CC33} = 3.3V ±5%, V_{CC25} = V_{CCR} = V_{CCA} = 2.5V ±5%, GND=0V

Table 17. DC Specifications

Symbol	Parameter	Min	Max	Unit	Condition
V _{IL}	Input Low Voltage	-0.5	0.8	Volt	
V _{IH}	Input High Voltage	2.0	V _{CC33} + 0.3	Volt	
V _{OL}	Output Low Voltage	—	0.45	Volt	I _{OL} = +4.0 mA
V _{OH}	Output High Voltage	2.4	—	Volt	I _{OH} = -1.0 mA
I _{IL}	Input Leakage Current	—	±10	uA	0 < V _{IN} < V _{CC33}
I _{OZ}	Tristate Leakage Current	—	±20	uA	0.45 < V _{OUT} < V _{CC33}

Power Consumption
Table 18. VT6105 Power Consumption

Power Consumption (Whole Card/No Boot ROM)	100Mbps		10Mbps	
	Current (mA)	Wattage (mW)	Current (mA)	Wattage (mW)
D0 (Without Cable)	48	0.12	48	0.12
D0	118	0.29	151	0.37
D3 cold (Without Cable)	40	0.1	40	0.1
D3 cold	110	0.27	40	0.1
D3 cold (Power Down)	7	0.01	7	0.01

Timing Specifications

PCI Bus Master

Descriptor Fetch - Burst Read

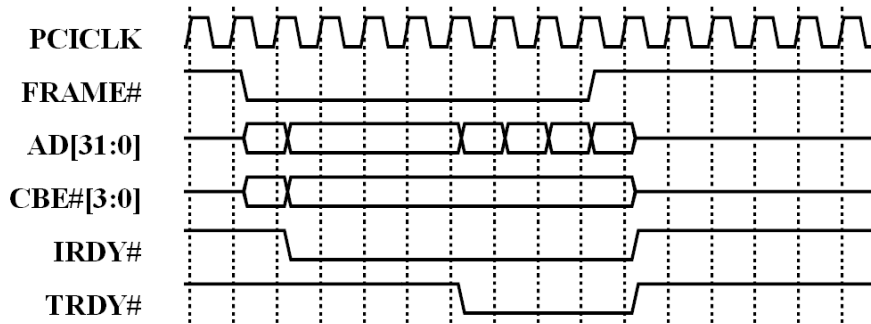


Figure 7. Descriptor Fetch

Status Write Back - Memory Write

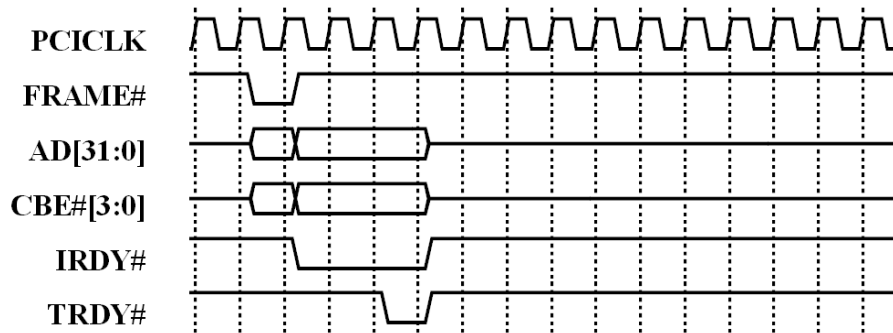


Figure 8. Write Back Status to Descriptor

Tx FIFO DMA - Burst Read with Memory-Read-Line, Memory-Read-Multiple-Enhance Commands

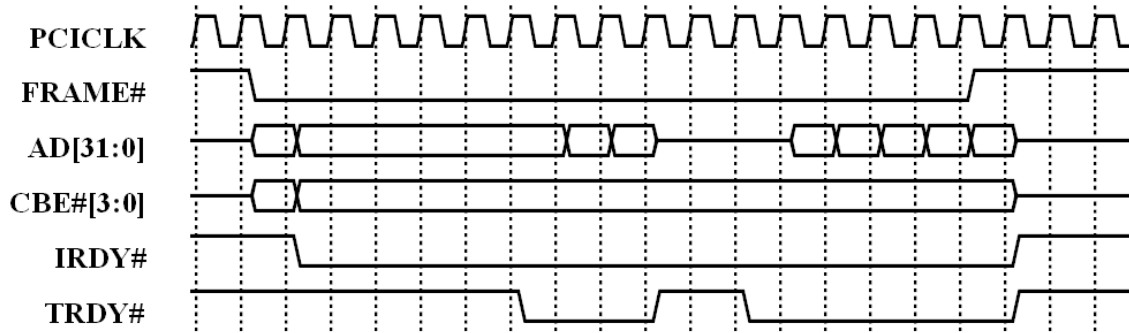


Figure 9. Memory Read (Tx FIFO DMA)

Rx FIFO DMA - Burst Memory Write

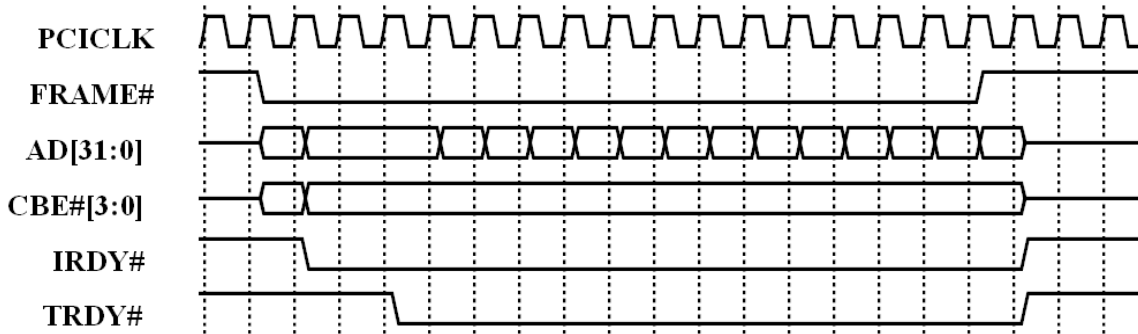


Figure 10. Memory Write (Rx FIFO DMA)

PCI Bus Slave

I/O Read/Write

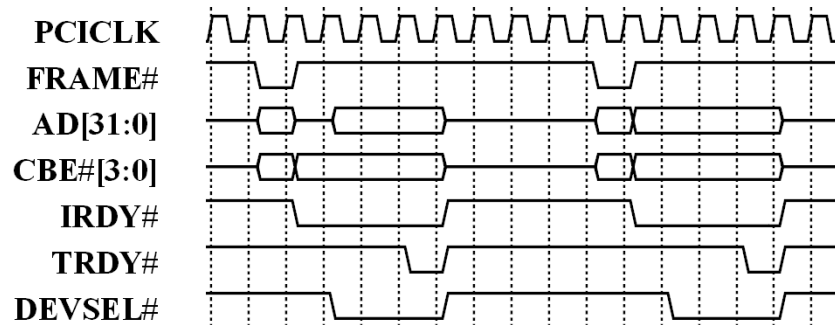


Figure 11. I/O Read/Write

Configuration Read/Write

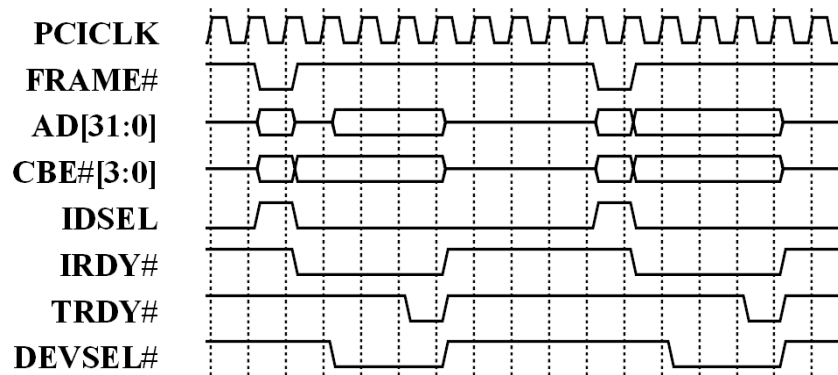


Figure 12. Configuration Read/Write

BootROM

Boot ROM Access Timing (with PCI Delay Transaction)

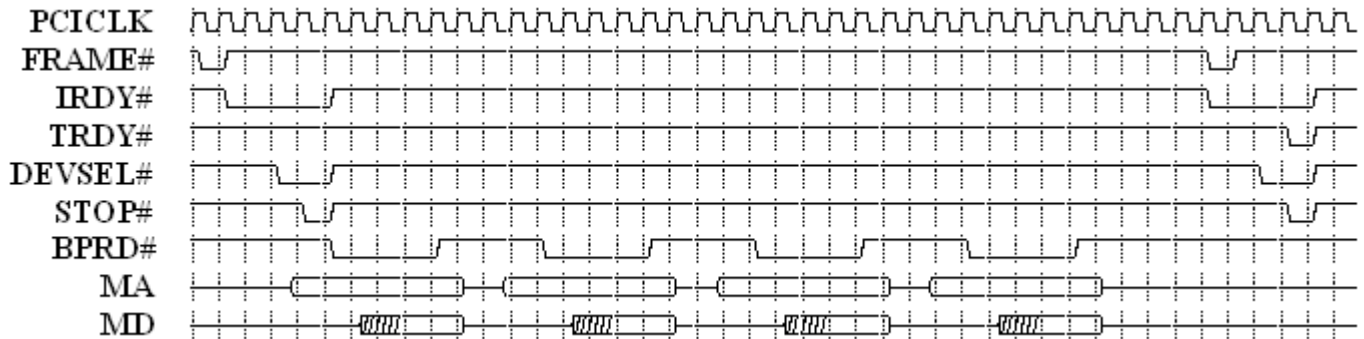


Figure 13. Boot ROM Access (with Delay Transaction)

BootROM Access Timing (without Delay Transaction)

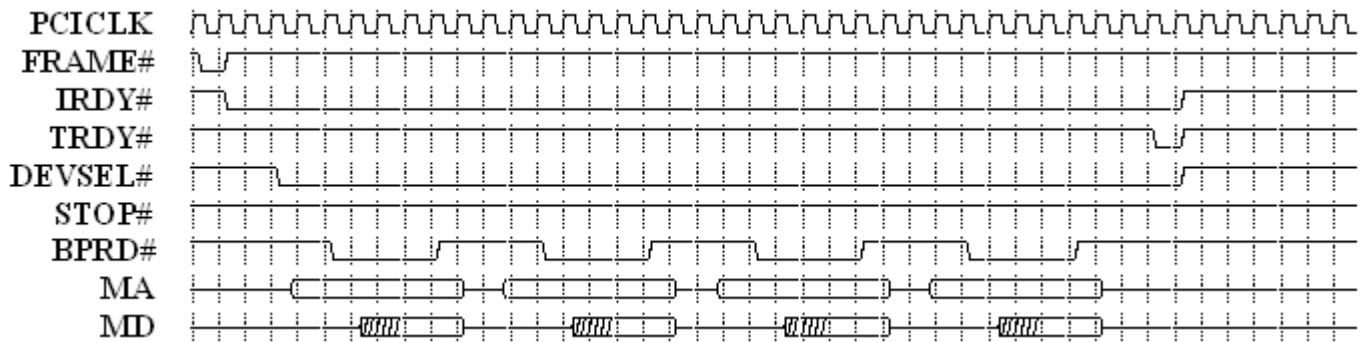


Figure 14. Boot ROM Access Timing (without Delay Transaction)

Embedded Flash Cycle Timing

Flash Write Timing (WE# Controlled Only)

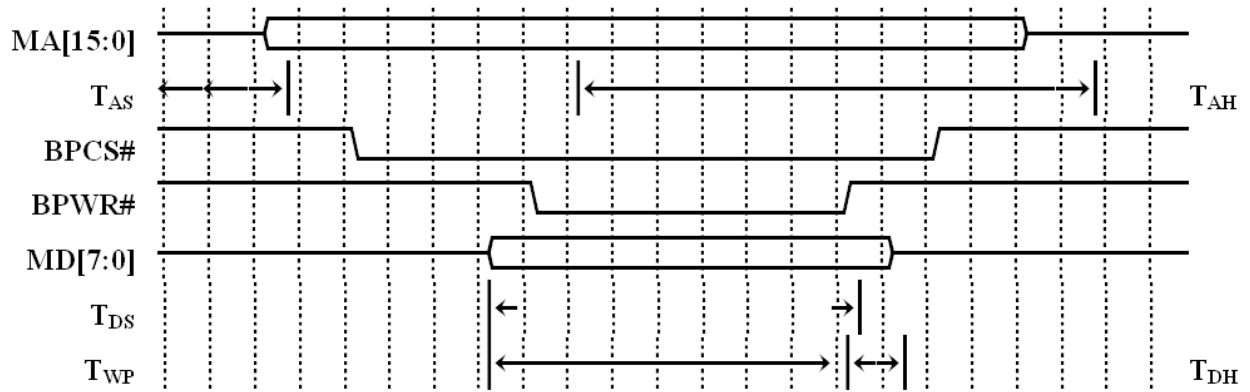


Figure 15. Flash Write Timing (WE# Controlled Only)

Symbol	Parameter	Min	Typ	Max	Unit
T _{AS}	Address Setup Time		116		ns
T _{AH}	Address Hold Time		423		ns
T _{DS}	Data Setup Time		298		ns
T _{DH}	Data Hold Time		61		ns
T _{WP}	BPWR# Pulse Width		270		ns

Flash Read Timing

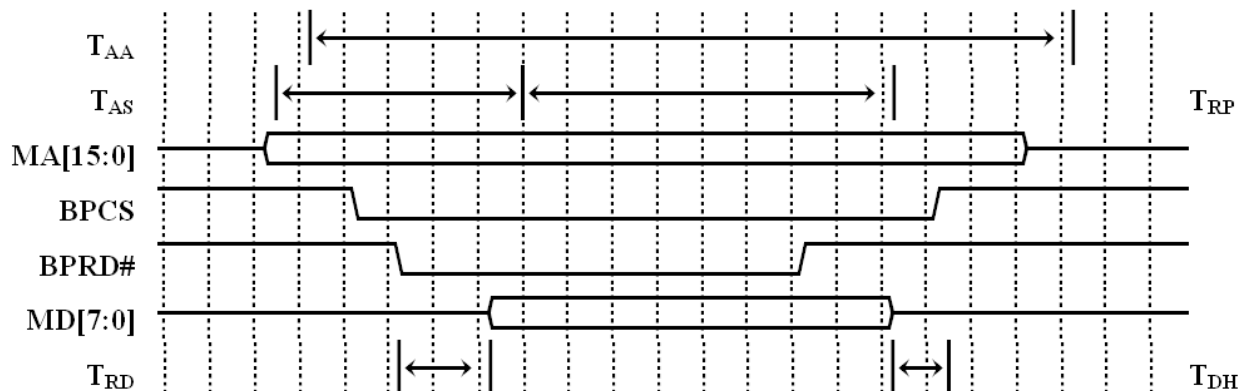


Figure 16. Flash Read Timing

Symbol	Parameter	Min	Typ	Max	Unit
T _{AS}	Address Setup Time		85		ns
T _{AA}	Address Cycle Time		508		ns
T _{RP}	BPWR# Pulse Width		330		ns
T _{RD}	Read Access Time			230	ns
T _{DH}	Data Hold Time			0	ns

LED Identification

LED ON/OFF ($0 < T_{pd} < 300$)

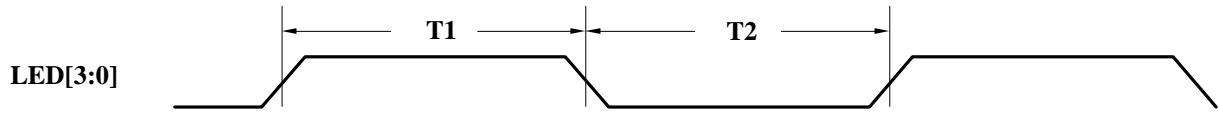


Figure 17. LED On/Off ($0 < T_{pd} < 300$)

Symbol	Parameter	Min	Typ	Max	Unit
T ₁	LED[3:0] On Time		68		ms
T ₂	LED[3:0] Off Time		68		ms

TP Interface

10BaseT Normal Link Pulse Timing (0 < Tpd < 300)

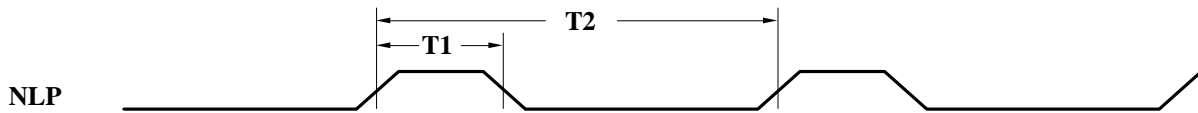


Figure 18. 10Base-T Normal Link Pulse Timing (0 < Tpd < 300)

Symbol	Parameter	Min	Typ	Max	Unit
T ₁	NLP Pulse Width		100		ns
T ₂	NLP TO NLP Period		12		ns

Auto Negotiation Fast Link Pulse Timing (0 < Tpd < 300)

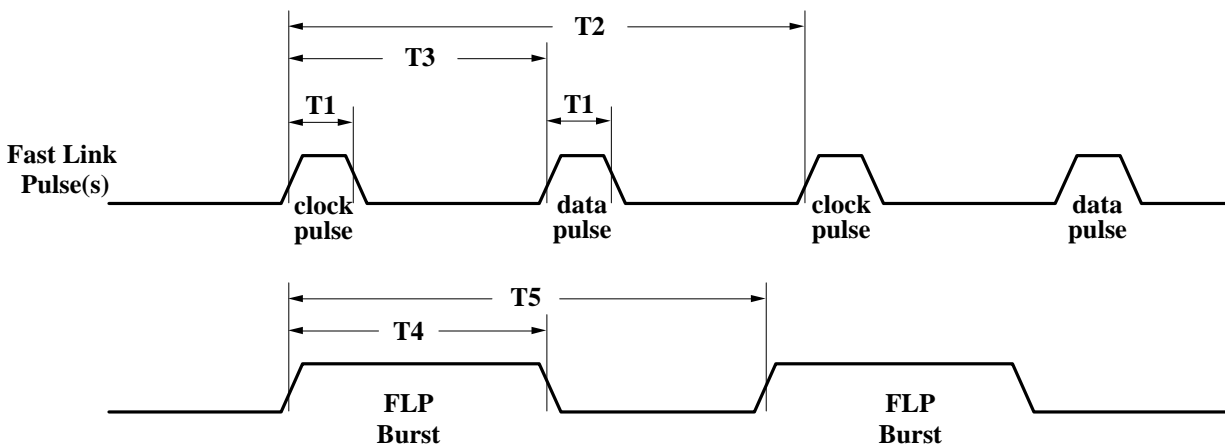


Figure 19. Auto Negotiation Fast Link Pulse Timing (0 < Tpd < 300)

Symbol	Parameter	Min	Typ	Max	Unit
T ₁	Clock, Data Pulse Width		100		ns
T ₂	Clock Pulse to Clock Pulse Period		125		μs
T ₃	Clock Pulse to Data Pulse Period		62.5		μs
T ₄	Burst Width		4.2		ns
T ₅	FLP Burst to FLP Burst Period		8.5		ns

Running State Software Driven Internal PHY Reset Timing:

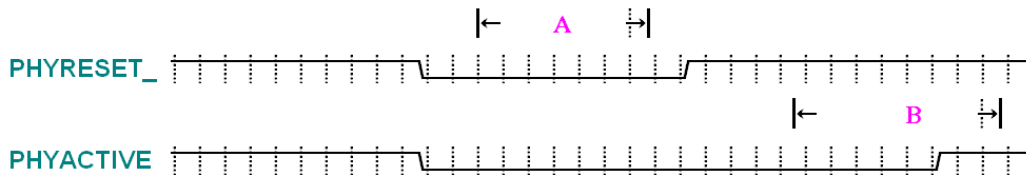
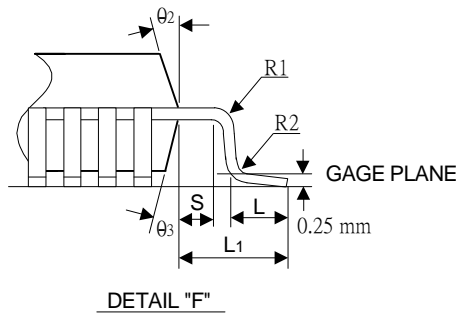
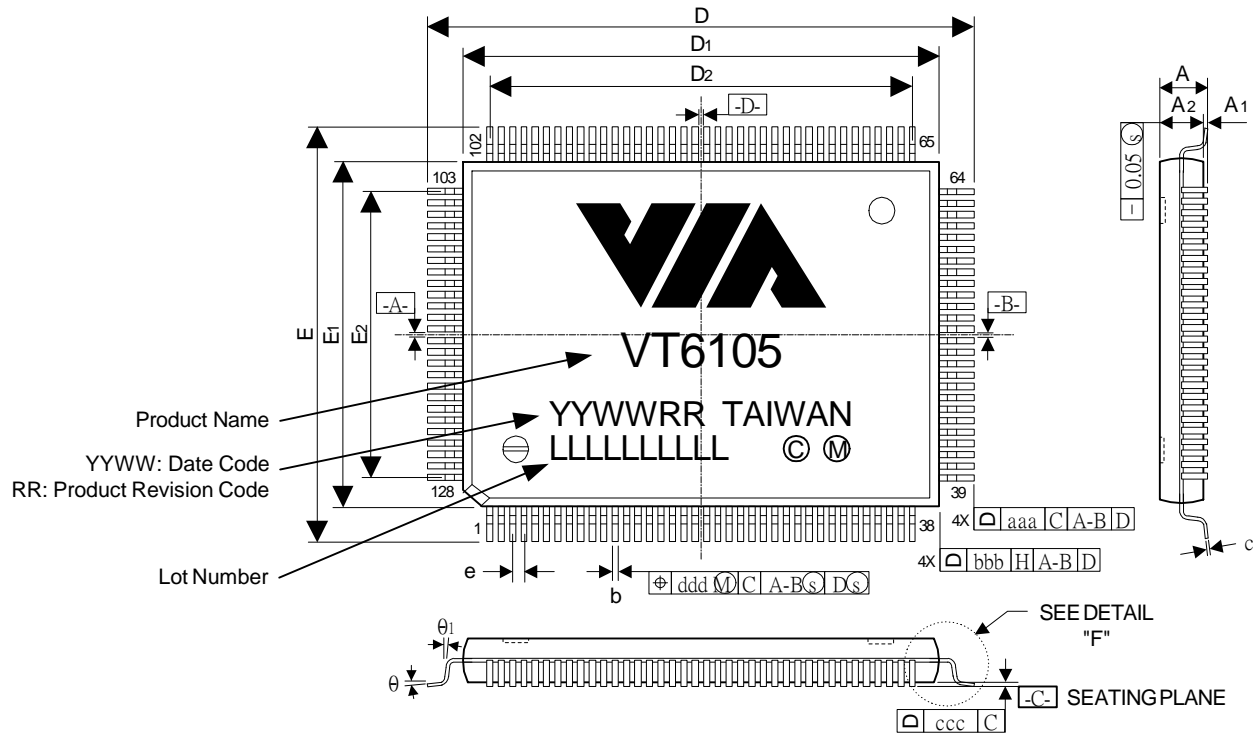


Figure 20. Running State Software Driven Internal PHY Reset Timing

Item	Description	Min	Max	Unit
A	Clock, Data Pulse Width	10		us
B	VT6105 PHY can begin to accept MDIO cycle after software initiated PHY Reset is de-asserted.	30		cyc
		1		uS

MECHANICAL SPECIFICATIONS



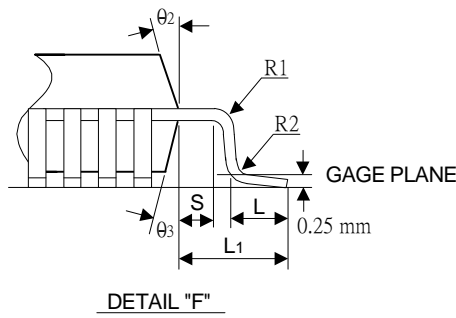
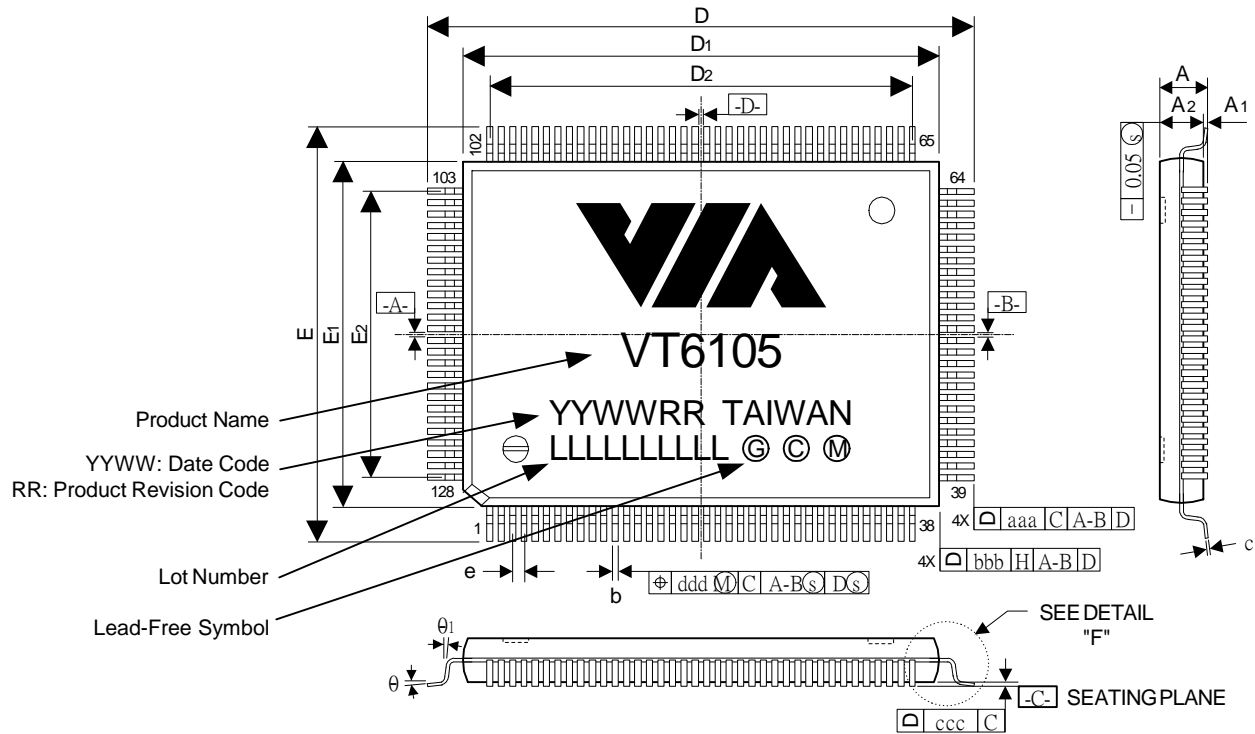
NOTES :

1. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 mm PER SIDE. D1 AND E1 ARE MAXIMUM PLASTIC BODY SIZE DIMENSIONS INCLUDING MOLD MISMATCH.
2. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED THE MAXIMUM b DIMENSION BY MORE THAN 0.08mm. DAMBAR CAN NOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD IS 0.07mm.

CONTROL DIMENSIONS ARE IN MILLIMETERS.

SYMBOL	MILLIMETER			INCH		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	—	—	3.40	—	—	0.134
A1	0.25	—	—	0.010	—	—
A2	2.50	2.72	2.90	0.098	0.107	0.114
D	23.20 BASIC			0.913 BASIC		
E	17.20 BASIC			0.677 BASIC		
D1	20.00 BASIC			0.787 BASIC		
E1	14.00 BASIC			0.551 BASIC		
D2	18.50 BASIC			0.728 BASIC		
E2	12.50 BASIC			0.492 BASIC		
R1	0.13	—	0.30	0.005	—	0.012
R2	0.13	—	—	0.005	—	—
theta	0	—	7	0	—	7
theta1	0	—	—	0	—	—
theta2	15 REF			15 REF		
theta3	15 REF			15 REF		
c	0.11	0.15	0.23	0.004	0.006	0.009
L	0.73	0.88	1.03	0.029	0.035	0.041
L1	1.60 REF			0.063 REF		
S	0.20	—	—	0.008	—	—
b	0.17	0.20	0.27	0.007	0.008	0.011
e	0.50 BASIC			0.020 BASIC		
TOLERANCES OF FORM AND POSITION						
aaa	0.20		0.008			
bbb	0.20		0.008			
ccc	0.08		0.003			
ddd	0.08		0.003			

Figure 21. PQFP-128 Package (14 x 20 mm)



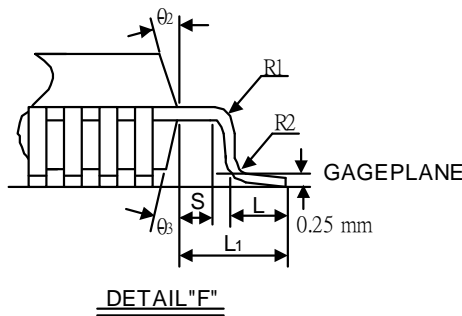
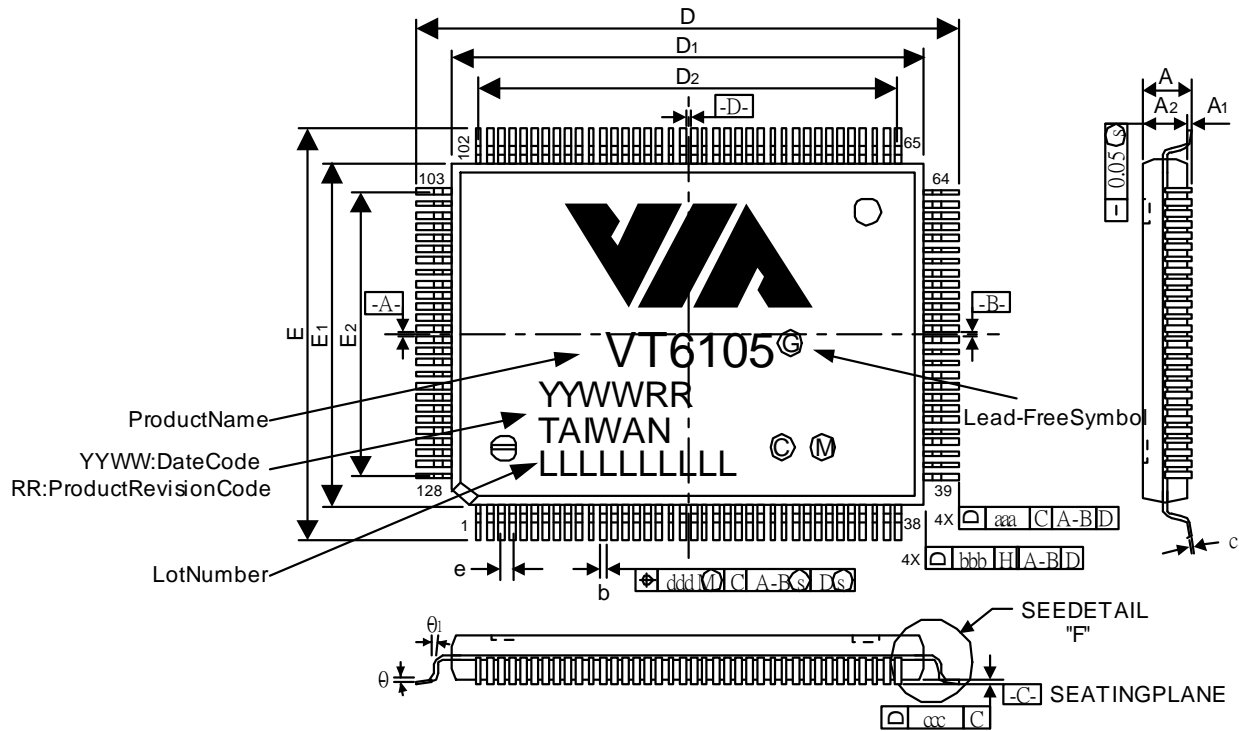
CONTROL DIMENSIONS ARE IN MILLIMETERS.

SYMBOL	MILLIMETER			INCH		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	—	—	3.40	—	—	0.134
A1	0.25	—	—	0.010	—	—
A2	2.50	2.72	2.90	0.098	0.107	0.114
D	23.20 BASIC			0.913 BASIC		
E	17.20 BASIC			0.677 BASIC		
D1	20.00 BASIC			0.787 BASIC		
E1	14.00 BASIC			0.551 BASIC		
D2	18.50 BASIC			0.728 BASIC		
E2	12.50 BASIC			0.492 BASIC		
R1	0.13	—	0.30	0.005	—	0.012
R2	0.13	—	—	0.005	—	—
theta	0	—	7	0	—	7
theta1	0	—	—	0	—	—
theta2	15 REF			15 REF		
theta3	15 REF			15 REF		
c	0.11	0.15	0.23	0.004	0.006	0.009
L	0.73	0.88	1.03	0.029	0.035	0.041
L1	1.60 REF			0.063 REF		
S	0.20	—	—	0.008	—	—
b	0.17	0.20	0.27	0.007	0.008	0.011
e	0.50 BASIC			0.020 BASIC		
TOLERANCES OF FORM AND POSITION						
aaa	0.20			0.008		
bbb	0.20			0.008		
ccc	0.08			0.003		
ddd	0.08			0.003		

NOTES :

- DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 mm PER SIDE. D1 AND E1 ARE MAXIMUM PLASTIC BODY SIZE DIMENSIONS INCLUDING MOLD MISMATCH.
- DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED THE MAXIMUM b DIMENSION BY MORE THAN 0.08mm. DAMBAR CAN NOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD IS 0.07mm.

Figure 22. Lead-Free PQFP-128 Package (14 x 20 mm)



NOTES :

1. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 mm PER SIDE. D1 AND E1 ARE MAXIMUM PLASTIC BODY SIZE DIMENSIONS INCLUDING MOLD MISMATCH.
2. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED THE MAXIMUM b DIMENSION BY MORE THAN 0.08mm. DAMBAR CAN NOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD IS 0.07mm.

CONTROL DIMENSIONS ARE IN MILLIMETERS.

SYMBOL	MILLIMETER			INCH		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	—	—	3.40	—	—	0.134
A1	0.25	—	—	0.010	—	—
A2	2.50	2.72	2.90	0.098	0.107	0.114
D	23.20BASIC			0.913BASIC		
E	17.20BASIC			0.677BASIC		
D1	20.00BASIC			0.787BASIC		
E1	14.00BASIC			0.551BASIC		
D2	18.50BASIC			0.728BASIC		
E2	12.50BASIC			0.492BASIC		
R1	0.13	—	0.30	0.005	—	0.012
R2	0.13	—	—	0.005	—	—
θ	0	—	7	0	—	7
θ1	0	—	—	0	—	—
θ2	15REF			15REF		
θ3	15REF			15REF		
c	0.11	0.15	0.23	0.004	0.006	0.009
L	0.73	0.88	1.03	0.029	0.035	0.041
L1	1.60REF			0.063REF		
S	0.20	—	—	0.008	—	—
b	0.17	0.20	0.27	0.007	0.008	0.011
e	0.50BASIC			0.020BASIC		
TOLERANCES OF FORM AND POSITION						
aaa	0.20			0.008		
bbb	0.20			0.008		
ccc	0.08			0.003		
ddd	0.08			0.003		

Figure 23. Lead-Free PQFP-128 Package (14 × 20 mm)